∆mplifiers



LM4931 Boomer® Audio Power Amplifier Series

Audio Subsystem with Mono High Efficiency Loudspeaker and Stereo Headphone Amplifiers

General Description

The LM4931 is an integrated audio subsystem that supports voice and digital audio functions. The LM4931 includes a high quality stereo DAC, voice band codec, a stereo headphone amplifier and a high-power high efficiency mono speaker amplifier. It is primarily designed for demanding applications in mobile phones and other portable devices.

The LM4931 features an I²S serial interface for full range audio, a 16-bit PCM bi-directional serial interface for the voice band codec and an I²C/SPI compatible interface for control. The full range music path features an SNR of 86dB with an 18-bit 48kHz input. The headphone amplifier delivers at least 26mW $_{\rm RMS}$ to a 32 Ω single-ended stereo load with less than 1% distortion (THD+N) when AV $_{\rm DD}=3.3V_{\rm DC}$. The mono speaker amplifier delivers up to 570mW $_{\rm RMS}$ into an 8 Ω load with less than 1% distortion when AV $_{\rm DD}=3.3V_{\rm DC}$.

The LM4931 employs advanced techniques to reduce power consumption, to reduce controller overhead, and to eliminate click and pop. Boomer audio power amplifiers were designed specifically to provide high quality output power with a minimal amount of external components. It is therefore ideally suited for mobile phone and other low voltage applications where minimal power consumption, PCB area, and cost are primary requirements.

Key Specifications

■ $P_{LS OUT}$ at $AV_{DD} = 5V$, 8Ω1% THD+N 1.1W (typ)

■ $P_{LS OUT}$ at $AV_{DD} = 3.3V$, 8Ω

1% THD+N 570mW (typ)

■ $P_{H/P \text{ OUT}}$ at $AV_{DD} = 5V \& AV_{DD} = 3.3V$, 32Ω1% THD+N 26mW (typ)

■ Supply voltage range

DV_{DD} 2.7V to 4.0V AV_{DD} (Note 8) 2.7V to 5.0V ■ Shutdown current 1.1μA (typ) ■ PSRR at 217Hz, AV_{DD} = 3V 62dB (typ) ■ SNR (Voice Codec) 75dB (typ) ■ SNR (Audio DAC) 86dB (typ)

Features

- 18-bit 44.1kHz or 48kHz stereo DAC
- 16-bit 8kHz , 12kHz , 16kHz, or 24kHz voice-band codec
- PLL for operation from common system clocks
- Either I²C or SPI compatible serial interface
- I²S digital audio data serial interface
- PCM voice audio data serial interface
- Differential analog microphone input
- 26mW/channel stereo headphone amplifier
- 570mW mono high efficiency BTL 8Ω amplifier
- 32-step volume control for audio output amplifiers with 1.5dB step size.
- Unity-gain stable headphone amplifiers
- No snubber networks or bootstrap capacitors are required by the headphone or hands-free amplifiers
- Adjustable digital side-tone attenuation
- 16-step volume control for microphone preamp with 2dB step size
- Configurable GPIO/Status Port
- Available in the 42 bump micro-SMD package

Applications

- 2.5 and 3G Mobile Phones and Multimedia Terminals
- PDAs, Internet Appliances and Portable Gaming
- Portable DVD/CD/AAC/MP3 Players
- Digital Cameras and Toys

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Typical Application

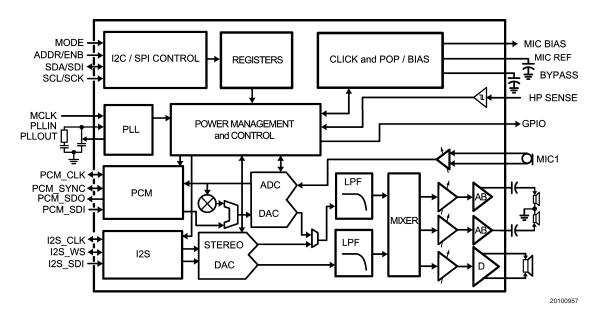
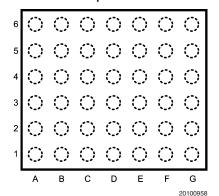


FIGURE 1. Typical I²S + Voice codec application circuit for mobile phones

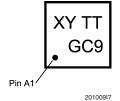
Connection Diagrams

42-Bump micro SMD



Top View (Bump Side Down) Order Number LM4931ITL See NS Package Number TLA42YVA

42-Bump micro SMD Marking



Top View XY - Date Code TT - Die Tracebility G - Boomer Family C9 - LM4931ITL

Pin Descriptions

PIN	PIN NAME	D/A	I/O	DESCRIPTION
A1	MIC_P	А	I	Microphone positive differential input
A2	MIC_N	Α	I	Microphone negative differential input
А3	VDD(MIC)	Α	I	Analog Vdd for microphone section
A4	MODE	D	I	Selects between SPI and I ² C control interfaces (I ² C = 0, SPI = 1)
A5	SDA/SDI	D	I/O	I ² C_SDA or SPI_SDI depending on the MODE control
A6	NC	N/A	N/A	No Connect
B1	MIC_P	Α	I	Microphone positive differential input
B2	MIC_BIAS	Α	0	2V ultra clean power supply for microphones
В3	BYPASS	Α	I	Click and Pop / VDD/2 reference filter
B4	ADDR/ENB	D	I	I ² C_ADDR or SPI_ENB depending on the MODE control
B5	SCL/SCK	D	I	I ² C_SCL or SPI_SCK depending on the MODE control
B6	PCM_SDI	D	I	PCM_SDI voice data input
C1	VSS(MIC)	А	I	Analog Vss for microphone section
C2	MIC_REF	А	I	Filter for microphone power supply
СЗ	NC	N/A	N/A	No Connect
C4	PCM_SDO	D	0	PCM_SDO serial data output
C5	PCM_SYNC	D	I/O	PCM_SYNC pulse for the PCM bus
C6	PCM-CLK	D	I/O	PCM_SYNC pulse for the PCM bus
D1	HPL	А	0	Left Headphone output
D2	VSS(HP)	А	I	Analog Vss for Headphone and Mixer sections
D3	VSS(HP)	А	I	Analog Vss for Headphone and Mixer sections
D4	I ² S_SDI	D	I	I ² S serial data input
D5	I ² S_CLK	D	I/O	I ² S clock signal
D6	VSSD	D	I	Digital Vss
E1	VDD(HP)	Α	I	Analog Vdd for Headphone and Mixer sections
E2	HPR	А	0	Right Headphone output
E3	GPIO	D	0	Configurable multi purpose output
E4	I ² S_WS	D	I/O	I ² S word select signal
E5	MCLK	D	I	Input clock from 10MHz - 24.576MHz
E6	VDDD	D	I	Digital Vdd
F1	LS+	А	0	Loudspeaker positive output
F2	VDD(LS)	А	I	Analog Vdd for Loudspeaker section
F3	HP_SENSE	А	I	Input for headphone connection sense circuit

Pin Descriptions (Continued)

F4	NC	N/A	N/A	No Connect
F5	PLL_OUT	D	0	PLL filter output
F6	VDD(PLL)	D	I	Digital Vdd for PLL section
G1	LS+	Α	0	Loudspeaker positive output
G2	VSS(LS)	Α	I	Analog Vss for Loudspeaker section
G3	LS-	Α	0	Loudspeaker negative output
G4	VSS(PLL)	D	I	Digital Vss for PLL section
G5	PLL_IN	D	I	PLL filter input
G6	VDD(PLL)	D	I	Digital Vdd for PLL section

Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Analog Supply Voltage 6.0V
Digital Supply Voltage 6.0V

Storage Temperature -65°C to +150°C Power Dissipation (Note 3) Internally Limited

ESD Susceptibility

Human Body Model (Note 4) 2500V Machine Model (Note 5) 200V Junction Temperature 150°C Thermal Resistance

 θ_{JA} - TLA42YVA 105°C/W

Operating Ratings

Temperature Range

 $T_{MIN} \le T_A \le T_{MAX}$ $-40^{\circ}C \le T_A \le +85^{\circ}C$

Supply Voltage

DV_{DD} (Note 8) 2.7V - 4.0V

AV_{DD} (Note 8) 2.7V - 5.0V

Electrical Characteristics $DV_{DD} = 3V$, $AV_{DD} = 3V$, $R_{LHP} = 32\Omega$, $R_{LHF} = 8\Omega$

(Notes 1, 2)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for $T_A = 25$ °C.

Symbol	Parameter	Conditions	LM4931		Units	
			Typical (Note 6)	Limits (Note 7)	(Limits)	
Power						
		Mode 0				
DI_SD	Digital Shutdown Current	f _{MLCK} = 12MHz (Note 9)	400	500	μA (max)	
		No MCLK	1	2	μA (max)	
DI _{ST}	Digital Standby Current	Mode 1, f _{MCLK} = 12MHz	400	1200	μA (max)	
		f _{MLCK} = 12MHz				
DI_DD	Digital Power Supply Current	Mode 2, 3, 4	1.3	3.2	mA (max)	
		Mode 5, 6, 7	2.8	7	mA (max)	
		Mode 8, 9, 10	3.2	7.5	mA (max)	
PLLI _{DD}	PLL Quiescent Current	f _{MCLK} = 12MHz	2.8	3.5	mA (max)	
Al _{SD}	Analog Shutdown Current	Mode 0, No load	0.1	2.5	μA (max)	
Al _{ST}	Analog Standby Current	Mode 1, No load	100	200	μA (max)	
		No Load				
	Analog Power Supply Quiescent Current	Mode 2	7.8	19	mA (max)	
		Mode 3	5.3	10	mA (max)	
A.I.		Mode 4	8.6	15	mA (max)	
Al_{DD}		Mode 5	8.4	15	mA (max)	
		Mode 6	6.0	15	mA (max)	
		Mode 7	9.2	15	mA (max)	
		Mode 8, 9, 10	10.1	16	mA (max)	
Loudspeake	r Amplifier		•			
V _{FS}	Full-Scale Output Voltage Loudspeaker Amplifier)	8Ω load, 0dB gain setting	2.6		V_{P-P}	
THD+N	Total Harmonic Distortion + Noise	$f_{OUT} = 1kHz, P_{OUT} = 200mW$	0.4		%	
P _{OLS}	Loudspeaker Amplifier Output Power	THD = 1% (max), f _{OUT} = 1kHz	470	350	mW (min)	
PSRR	Power Supply Rejection Ratio (Loudspeaker Amplifier)	$C_B = 1.0\mu F$ $V_{RIPPLE} = 200 \text{mV}_{P-P}$ $f_{RIPPLE} = 217 \text{Hz}$	54		dB	
		$\begin{aligned} & \text{Signal} = \text{V}_{\text{O}} \text{ at 0dBFS, f} = \text{1kHz,} \\ & \text{Noise} = \text{digital zero, A-weighted,} \\ & \text{0dB gain setting (Note 10)} \end{aligned}$				
SNR (Voice)	Signal-to-Noise Ratio of Voice Channel (Loudspeaker Amplifier)	f _{MCLK} = 12.288MHz, PLL disabled	71		dB	

Electrical Characteristics DV $_{\rm DD}$ = 3V, AV $_{\rm DD}$ = 3V, R $_{\rm LHP}$ = 32 $\!\Omega,$ R $_{\rm LHF}$ = 8 $\!\Omega$

(Notes 1, 2) (Continued)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

Symbol	Parameter	Conditions	LM4931		Units	
			Typical (Note 6)	Limits (Note 7)	(Limits)	
		f _{MCLK} = 12MHz, PLL active	70		dB	
		Signal = V _O at 0dBFS, f = 1kHz,				
	Signal-to-Noise Ratio of Music	Noise = digital zero, A-weighted,				
SNR (Music)	Channel (Loudspeaker Amplifier)	0dB gain setting (Note 10)				
, ,	Output Noise	f _{MCLK} = 12.288MHz, PLL disabled	78		dB	
		f _{MCLK} = 12MHz, PLL active	(Note 6) (Note 7) 70 70 d 78 76 o (Note d 120 140 10 -34.5 12 1.5 2.6 0.04 26 19 62 and 1% d 75 73 and 1%	dB		
		A-weighted filter, V _{in} = digital zero (Note				
		10)				
e _N (Music)	Output Noise	f _{MCLK} = 12.288MHz, PLL disabled	120		μV	
		f _{MCLK} = 12MHz, PLL active			μV	
V _{os}	Offset Voltage	IMCLK = 121W12, 1 22 doubt			mV	
VOS	Volume Control Range	Minimum Gain	+		dB	
VCR	(Loudspeaker Amplifier)	Willimum Gain	-34.5		ив	
		Maximum Gain	12		dB	
SS	Volume Control Step Size		1.5		dB	
	(Loudspeaker Amplifier)					
Headphone A	Amplifier					
V _{FS}	Full Scale Ouput Voltage	32Ω load, 0dB gain setting	2.6		V _{P-P}	
	(Headphone Amplifier)					
THD+N	Total Harmonic Distortion + Noise	$f_{IN} = 1kHz, P_{OUT} = 7.5mW,$	0.04		%	
	(Headphone Amplifier)	32Ω stereo load				
P _{OHP}	Output Power (Headphone Amplifier)	THD = 0.5%, f _{OUT} = 1KHz	26	19	mW (min	
PSRR	Power Supply Rejection Ratio	С _В = 1.0µF	62		dB	
	(Headphone Amplifier)	V _{RIPPLE} = 200mV _{PP}				
	(f _{RIPPLE} = 217Hz				
		Signal = V _O at 0dBFS, f = 1kHz and 1%				
		THD+N,				
	Signal-to-Noise Ratio of Voice	Noise = digital zero, A-weighted,				
SNR (Voice)	Channel (Headphone Amplifier)	OdB gain setting (Note 10)				
	Charmer (Fleadphone Ampliner)	f _{MCLK} = 12.288MHz, PLL disabled	75		dB	
		f _{MCLK} = 12MHz, PLL active	_		dB	
			75		ub_	
		Signal = V _O at 0dBFS, f = 1kHz and 1%				
	G. I. N D	THD+N, Noise = digital zero, A-weighted,				
SNR (Music)	Signal-to-Noise Ratio of Music	OdB gain setting (Note 10)				
	Channel (Headphone Amplifier)		00		-dD	
		f _{MCLK} = 12.288MHz, PLL disabled			dB	
.,		f _{MCLK} = 12MHz, PLL active			dB	
X_{TALK}	Stereo Channel-to-Channel	$f_S = 48kHz$,	62		dB	
	Crosstalk	f _{IN} = 1kHz sinewave at -3dBFS			-	
ΔA_{CH-CH}	Stereo Channel-to-Channel Gain Mismatch		0.3		dB	
		A-weighted filter,				
		Vin = digital zero (Note 10)				
e _N (Music)	Output Noise	f _{MCLK} = 12.288MHz, PLL disabled	45		μV	
e _N (Music)	I.	ozn	1			

Electrical Characteristics DV $_{\rm DD}$ = 3V, AV $_{\rm DD}$ = 3V, R $_{\rm LHP}$ = 32 $\!\Omega,\,$ R $_{\rm LHF}$ = 8 $\!\Omega$

(Notes 1, 2) (Continued)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

Symbol	Parameter	Conditions	LM4931		Units
•			Typical (Note 6)	Limits (Note 7)	(Limits)
	Volume Control Range	Minimum Gain	-46.5		dB
VCR	(Headphone Amplifier)	Maximum Gain	0		dB
SS	Volume Control Stepsize		1.5		dB
	(Headphone Amplifier)				
Microphone A	Amplifier		•		
V _{BIAS}	Mic Bias Voltage		2		V
000	Gain Control Range (Microphone	Minimum Gain	6		dB
GCR	Amplifier)	Maximum Gain	36		dB
SS	Gain Control Stepsize (Microphone Amplifier)		2		dB
Voice Codec	(Typical numbers are with 1.024M	Hz voice clock and 8kHz sampling freque	ncy)		
R _{VDAC}	Voice DAC Ripple	300Hz-3.3kHz through headphone output.	+/- 0.15		dB
R _{VADC}	Voice ADC Ripple	300Hz-3.3kHz through headphone output.	+/- 0.25		dB
PB _{VDAC}	Voice DAC Passband	-3dB Point	3.46		kHz
SBA _{VDAC}	Voice DAC Stopband Attenuation	Above 4kHz	72		dB
UPB _{VDAC}	Upper Passband Cutoff Frequency	Upper – 3dB Point	3.47		kHz
LPB _{VDAC}	Lower Passband Cutoff Frequency	Lower – 3dB Point	0.230		kHz
SBA _{VADC}	Voice ADC Stopband Attenuation	Above 4kHz	65		dB
SBA _{NOTCH}	Voice ADC Notch Attenuation	Centered on 55Hz, figure gives worst	58		dB
NOTON		case attenuation for 50Hz & 60Hz			
SNR (Voice)	Signal-to-Noice Ratio of Voice Channel (Voice ADC path)	Signal = V _O at 0dBFS, f = 1kHz and 1% THD+N, MIC_P, MIC_N Terminated to ground, A-weighted, 36dB MIC Preamp gain setting (Note 10)			
		f _{MCLK} = 12.288MHz, PLL disabled	81		dB
		f _{MCLK} = 12MHz, PLL active	80		dB
STR	Side Tone Range	Minimum Gain	-30		dB
		Maximum Gain	0		dB
SS	Side Tone Step Size		3		dB
Audio DAC (Typical numbers are with 6.144MH	z audio clock and 48kHz sampling freque	ncy)		
R _{DAC}	Audio DAC Ripple	20Hz-20kHz through headphone output	+/-0.1		dB
PB _{DAC}	Audio DAC Passband width	-3dB point	22.7		kHz
SBA _{DAC}	Audio DAC Stop band Attenuation	Above 24kHz	76		dB
DR _{DAC}	Audio DAC Dynamic Range	DC – 20kHz	97		dB
SNR _{DAC}	Audio DAC SNR Digital Filter	DC – 20kHz	97		dB
	Section				
PLL			1		
f _{IN}	Input Frequency on MCLK pin		12	10 25	MHz (min) MHz (max)
SPI/I ² C					
f _{SPI}	Maximum SPI Frequency		400	4000	kHz (max)
t _{SPISETD}	SPI Data Setup Time			100	ns (min)
t _{SPISETENB}	SPI ENB Setup Time			100	ns (min)
t _{SPIHOLDD}	SPI Data Hold Time		1	100	ns (min)

Electrical Characteristics DV $_{\rm DD}$ = 3V, AV $_{\rm DD}$ = 3V, R $_{\rm LHP}$ = 32 $\!\Omega,$ R $_{\rm LHF}$ = 8 $\!\Omega$

(Notes 1, 2) (Continued)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for $T_A = 25$ °C.

Symbol	Parameter	Conditions	LM4	1931	Units	
			Typical	Limits	(Limits)	
			(Note 6)	(Note 7)		
t _{SPIHOLDENB}	SPI ENB Hold Time			100	ns (min)	
t _{SPICL}	SPI Clock Low Time			500	ns (min)	
t _{SPICH}	SPI Clock HighTime			500	ns (min)	
t _{SPIT}	SPI Clock Transition Time			5	ns (min)	
f _{CLKI2C}	I ² C_CLK Frequency		400	3400	kHz (max)	
t _{I2CHOLD}	I ² C_DATA Hold Time			100	ns (min)	
t _{I2CSET}	I ² C_DATA Setup Time			100	ns (min)	
PCM/I ² S						
f _{CLKPCM}	PCM_CLK Frequency		128		kHz	
	PCM_CLK Duty Cycle		50	40	% (min)	
				60	% (max)	
	I ² S_CLK Frequency	$I^2S_RES = 0$	1536		kHz	
f _{CLKI2S}		$I^2S_RES = 1$	3072		kHz	
	I ² S_WS Duty Cycle		50	40	% (min)	
				60	% (max)	

Electrical Characteristics DV_{DD} = 3.3V, AV_{DD} = 5V, R_{LHP} = 32 Ω , R_{LHF} = 8 Ω (Notes 1, 2)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for T_A = 25°C.

Symbol	Parameter	Conditions	LM ⁴	4931	Units
			Typical (Note 6)	Limits (Note 7)	(Limits)
Power			l		
		Mode 0			
DI_SD	Digital Shutdown Current	f _{MCLK} = 12MHz (Note 9)	500	600	μA (max)
		No MCLK	1		μA (max)
DI _{ST}	Digital Standby Current	Mode 1, f _{MCLK} = 12MHz	500	1600	μA (max)
		f _{MCLK} = 12MHz			
DI	Digital Power Supply Current	Mode 2, 3, 4	1.6	3.5	mA (max)
DI_DD	Digital Fower Supply Current	Mode 5, 6, 7	3.5	8	mA (max)
		Mode 8, 9, 10	4.0	8	mA (max)
PLLI _{DD}	PLL Quiescent Current	f _{MCLK} = 12MHz	3.3	4	mA (max)
AI_{DD}	Analog Shutdown Current	Mode 0, No Load	0.6	3	μA (max)
Al _{ST}	Analog Standby Current	Mode 1, No Load	220	450	μA (max)
		No Load			
		Mode 2	18.5	32	mA (max)
		Mode 3	7.3	12	mA (max)
۸۱	Analog Power Supply Quiescent	Mode 4	19.6	29	mA (max)
Al_{DD}	Current	Mode 5	19.4	30	mA (max)
		Mode 6	8.4	26	mA (max)
		Mode 7	20.5	30	mA (max)
		Mode 8, 9, 10	22	32	mA (max)
Loudspeake	r Amplifier			•	

Electrical Characteristics DV $_{\rm DD}$ = 3.3V, AV $_{\rm DD}$ = 5V, R $_{\rm LHP}$ = 32 $\Omega,$ R $_{\rm LHF}$ = 8 Ω

(Notes 1, 2) (Continued)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

Symbol	Parameter	Conditions	LM ²	Units	
			Typical (Note 6)	Limits (Note 7)	(Limits)
V _{FS}	Full-Scale Output Voltage (Mono speaker amplifie)r	8 Ω load, 0dB gain setting	2.6		V_{P-P}
THD+N	Total Harmonic Distortion + Noise	f _{OUT} = 1kHz, P _{OUT} = 400mW	0.16		%
P _{OLS}	Loudspeaker Amplifier Output Power	THD = 1%, f _{OUT} = 1kHz	1.1		W
PSRR	Power Supply Rejection Ratio (Loudspeaker Amplifier)	$C_B = 1.0\mu F$ $V_{RIPPLE} = 200 m V_{PP}$ $f_{RIPPLE} = 217 Hz$	56		dB
SNR (Voice)	Signal-to-Noise Ratio of Voice Channel (Loudspeaker Amplifier)	Signal = V _O at 0dBFS, f = 1kHz Noise = digital zero, A-weighted 0dB gain setting (Note 10) f _{MCLK} = 12.288MHz, PLL disabled	70		dB
SNR (Music)	Signal-to-Noise Ratio of Music Channel (Loudspeaker Amplifier)	f _{MCLK} = 12MHz, PLL active Signal = V _O at 0dBFS, f = 1kHz Noise = digital zero, A-weighted 0dB gain setting (Note 10)	69		dB
	Chairier (Essaspearer / Impilier /	f _{MCLK} = 12.288MHz, PLL disabled f _{MCLK} = 12MHz, PLL active	74 73		dB dB
e _N (Music)	Output Noise	A-Weighted filter, V_{IN} = digital zero (Note 10) $f_{MCLK} = 12.288MHz, PLL disabled$ $f_{MCLK} = 12MHz, PLL active$	250 320		μV μV
V _{OS}	Offset Voltage		10		mV
VCD	Volume Control Range	Minimum Gain	-34.5		dB
VCR	(Loudspeaker Amplifier)	Maximum Gain	12		dB
SS	Volume Control Step Size		1.5		dB
Headphone A	Amplifier		'	'	
V _{FS}	Full-Scale Output Voltage (Headphone Amplifier)	32Ω stereo load, 0dB gain setting	2.6		V_{P-P}
THD+N	Total Harmonic Distortion + Noise (Headphone Amplifier)	f_{IN} = 1kHz, P_{OUT} = 7.5mW 32 Ω stereo load	0.05		%
P _{OHP}	Output Power (Headphone Amplifier)	THD = 0.5%, f _{OUT} = 1kHz	26	20	mW (min)
PSRR	Power Supply Rejection Ratio (Headphone Amplifier)	$C_B = 1.0 \mu F$ $V_{RIPPLE} = 200 m V_{PP}$ $f_{RIPPLE} = 217 Hz$	70		dB
SNR (Voice)	Signal-to-Noise Ratio of Voice Channel (Headphone Amplifier)	Signal = V_O at f = 1kHz and 1% THD+N, Noise = digital zero, A-weighted 0dB gain setting (Note 10) f_{MCLK} = 12.288MHz, PLL disabled	75		dB
		f_{MCLK} = 12MHz, PLL active Signal = V_O at f = 1kHz and 1% THD+N, Noise = digital zero, A-weighted	73		dB
SNR (Music)	Signal-to-Noise Ratio of Music Channel (Headphone Amplifier)	0dB gain setting (Note 10) f _{MCLK} = 12.288MHz, PLL disabled	86		dB
		f _{MCLK} = 12MHz, PLL active	82		dB

Electrical Characteristics DV $_{\rm DD}$ = 3.3V, AV $_{\rm DD}$ = 5V, R $_{\rm LHP}$ = 32 $\Omega,$ R $_{\rm LHF}$ = 8 Ω

(Notes 1, 2) (Continued)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

Symbol	Parameter	Conditions	LM4	1931	Units	
			Typical (Note 6)	Limits (Note 7)	(Limits)	
<u></u>	Stereo Channel-to-Channel	f _S = 48kHz	62		dB	
X _{TALK}	Crosstalk	f _{IN} = 1kHz sinewave at -3dBFS	02		uБ	
	Stereo Channel-to-Channel Gain	THE THE STREET STREET				
ΔA_{CH-CH}	Mismatch		0.3		dB	
		A-Weighted filter				
e _N (Music)	Output Noise	V _{IN} = digital zero (Note 10)				
CN (Masic)	Catput Noise	f _{MCLK} = 12.288MHz, PLL disabled	45		μV	
		f _{MCLK} = 12MHz, PLL active	70		μV	
VCR	Volume Control Range	Minimum Gain	-46.5		dB	
	(Headphone Amplifier)	Maximum Gain	0		dB	
SS	Volume Control Step Size		1.5		dB	
	(Headphone Amplifier)					
Microphone A	-			Г		
V _{BIAS}	Mic Bias Voltage		2		V	
GCR	Gain Control Range (Microphone	Minimum Gain	6		dB	
	Amplifier)	Maximum Gain	36		dB	
SS	Gain Control Step Size		2		dB	
Voice Codec	1	dz voice clock and 8kHz sampling frequer				
R_{VDAC}	Voice DAC Ripple	300Hz - 3.3kHz through headphone	+/-0.15		dB	
		output	,			
R _{VADC}	Voice ADC Ripple	300Hz - 3.3kHz through headphone	+/-0.25		dB	
	W : 540 5 1 1	output	0.40			
PB _{VDAC}	Voice DAC Passband	-3dB Point	3.46		kHz	
SBA _{VDAC}	Voice DAC Stopband Attenuation	Above 4kHz	72		dB	
UPB _{VADC}	Upper Passband Cutoff Frequency	Upper – 3dB Point	3.47		kHz	
LPB _{VADC}	Lower Passband Cutoff Frequency		0.230		kHz	
SBA _{VADC}	Voice ADC Stopband Attenuation	Above 4kHz	65		dB	
SBA _{NOTCH}	Voice ADC Notch Attenuation	Centered on 55Hz, figure gives worst case attenuation for 50Hz & 60Hz	58		dB	
	1	Signal = V_O at f = 1kHz and 1% THD+N,				
		MIC_P, MIC_N terminated to ground,				
	Signal-to-Noise Ratio of Voice	A-weighted, 36dB MIC Preamp gain				
SNR (Voice)	Channel (Voice ADC path)	setting (Note 10)				
	, , ,	f _{MCLK} = 12.288MHz, PLL disabled	83		dB	
		f _{MCLK} = 12MHz, PLL active	81		dB	
STR	Side Tone Range	Minimum	-30		dB	
	_	Maximum	0		dB	
SS	Side Tone Step Size		3		dB	
Audio DAC (•	z audio clock and 48kHz sampling frequen	icy)	l		
R _{DAC}	Audio DAC Ripple	20Hz – 20kHz through headphone output	+/- 0.1		dB	
PB _{DAC}	Audio DAC Passband width	-3dB point	22.7		kHz	
SBA _{DAC}	Audio DAC Stop band Attenuation	Above 24kHz	76		dB	
DR _{DAC}	Audio DAC Dynamic Range	DC – 20kHz	97		dB	
SNR _{DAC}	Audio DAC SNR Digital Filter	DC – 20kHz	97		dB	

Electrical Characteristics DV_{DD} = 3.3V, AV_{DD} = 5V, R_{LHP} = 32 Ω , R_{LHF} = 8 Ω

(Notes 1, 2) (Continued)

The following specifications apply for the circuit shown in Figure 1, unless otherwise specified. Limits apply for T_A= 25°C.

Symbol	Parameter	Conditions	LM ²	LM4931	
			Typical	Limits	(Limits)
			(Note 6)	(Note 7)	
f _{IN}	Input Frequency on MCLK pin		12	10	MHz (min)
	here after 19 and 1			20	MHz (max)
SPI/I ² C					
f _{SPI}	Maximum SPI Frequency		400	4000	kHz (max)
t _{SPISETD}	SPI Data Setup Time			100	ns (min)
t _{SPISETENB}	SPI ENB Setup Time			100	ns (min)
t _{SPISETHOLDD}	SPI Data Hold Time			100	ns (min)
t _{SPIHOLDENB}	SPI ENB Hold Time			100	ns (min)
t _{SPICL}	SPI Clock Low Time			500	ns (min)
t _{SPICH}	SPI Clock High Time			500	ns (min)
t _{SPIT}	SPI Clock TransitionTime			5	ns (min)
t _{CLKI2C}	I ² C_CLK Frequency		400	3400	kHz (max)
t _{I2CHOLD}	I ² C_DATA Hold Time			100	ns (min)
t _{I2CSET}	I ² C_DATA Setup Time			100	ns (min)
PCM/I ² S					
f _{CLKPCM}	PCM_CLK Frequency		128		kHz
	PCM_CLK Duty Cycle		50	40	% (min)
	PCIVI_CLK Duty Cycle		50	60	% (max)
f	I ² S_CLK Frequency	$I^2S_RES = 0$	1536		kHz
f _{CLKI2S}	1 0_OLK Hequency	$I^2S_RES = 1$	3072		NI IZ
	I ² S_WS Duty Cycle		50	40	% (min)
	1 0_W3 Daty Cycle		30	60	% (max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 2: All voltages are measured with respect to the relevant GND pin unless otherwise specified. All grounds should be coupled as close as possible to the device.

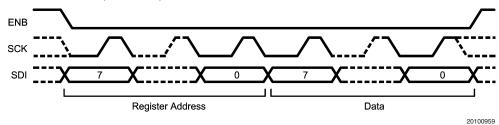
Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower. For the LM4931, see power derating currents for more information.

- Note 4: Human body model: 100pF discharged through a $1.5k\Omega$ resistor.
- Note 5: Machine model: 220pF 240pF discharged through all pins.
- Note 6: Typicals are measured at 25°C and represent the parametric norm.
- Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).
- Note 8: Best operation is achieved by maintaining $3.0V \le AV_{DD} \le 5.0$ and $3.0V \le DV_{DD} \le 3.6V$ and $AV_{DD} \ge DV_{DD}$.
- Note 9: Digital shutdown current is measured with system clock set for PLL output while the PLL is disabled.
- Note 10: Disabling or bypassing the PLL will result in an improvement in noise measurements.
- Note 11: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

System Control

The LM4931 is controlled via either a three wire SPI or a two wire I²C compatible interface, selectable with the MODE pin When MODE is cleared the device is in I²C mode, when MODE is set the device is in SPI mode. This interface is used to configure the operating mode, interfaces, data converters, mixers and amplifiers. The LM4931 is controlled by writing 8 bit data into a series of write-only registers, the device is always a slave for both type of interfaces.

THREE WIRE, SPI INTERFACE (MODE = 1)



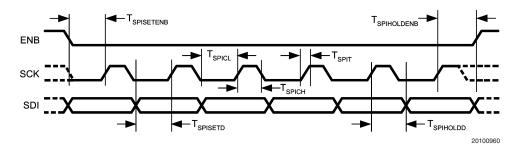


FIGURE 2.

When the part is configured as an SPI device and the enable (ENB) line is lowered the serial data on SDI is clocked in on the rising edge of the SCK line. The protocol used is 16bit, MSB first. The upper 8 bits (15:8) are used to select an address within the device, the lower 8 bits (7:0) contain the updated data for this register.

TWO WIRE I2C COMPATIBLE INTERFACE (MODE = 0)

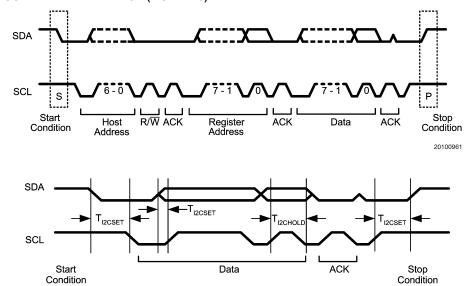


FIGURE 3.

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System Control (Continued)

When the part is configured as an I^2C device then the LM4931 will respond to one of two addresses, according to the ADDR input. If ADDR is low then the address portion of the I^2C transaction should be set to write to 0010000. When ADDR is high then the address input should be set to write to 1110000. The LM4931 uses the following 11 registers to store configuration information:

SYSTEM CONTROL TABLE

Address	Register Name	Description
00000000	BASIC_CONFIG	Controls the output mode configuration
0000001	VOICE_CONFIG	Controls the settings for the voice codec
0000010	MIC_GAIN	Controls the gain and muting of the microphone pre-amplifier
00000011	HP_GAIN	Controls the gain and muting of the headphone amplifier
00000100	LS_GAIN	Controls the gain and muting of the loudspeaker amplifier
00000101	PLL_M	Sets the PLL input divider
00000110	PLL_N	Sets the PLL feedback divider
00000111	PLL_P	Sets the PLL output divider
00001000	CLK_MUX	Configures the clock divider
00001001	INTERFACES	Controls the format of the PCM, I ² S and GPIO interfaces
00001010	PMC_CONFIG	Controls the power management functions

Basic Configuration Register

This register used to configure the basic function of the chip.

DEFAULT CHART FOR BASIC_CONFIG (00h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

BASIC_CONFIG (00h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Description							
3:0	MODE	When a new	can be placed in one mode is selected the he power management to 13)	LM4931 will cha	inge operation siler	ntly and will			
		3:0	Mono Speaker Amplifier Source	Headphone Left Source	Headphone Right Source	Comment			
		0000	None	None	None	Powerdown mode			
		0001	None	None	None	Standby mode			
		0010	Voice	None	None	Mono speaker mode			
		0011	None	Voice	Voice	Headphone call mode			
		0100	Voice	Voice	Voice	Conference call mode			
		0101	Audio (L+R)	None	None	L+R mixed to mono speaker			
		0110	None	Audio (Left)	Audio (Right)	Headphone stereo audio			
		0111	Audio (L+R)	Audio (Left)	Audio (Right)	L+R mixed to mono speaker + stereo headphone audio			
		1000	Audio (Left)	Voice	Voice	Mixed mode			
		1001	Voice + Audio (Left)	Voice	Voice	Mixed mode			
		1010	Voice	Audio (Left)	Audio (Left)	Mixed mode			
4	SOFTRESET		the LM4931, excludir	_	gisters and PLL. So	OFTRESET should			
5	DAC_ DITHER_OFF	Disables the	audio DAC dither.						
6		S If set the power management and control circuit will assume that bypass is at V _{DD} /2 even when such condition is false. (Note 12)							
7	RSVD	RESERVED	(Note 14)						

Note 12: It is recommended to alter this bit only while the part is in Powerdown mode.

Note 13: Modes 8, 9, and 10 are only available if the sample rate of the I²S is an integer multiple of the sample rate of the PCM. For example, 48kHz (I²S) and 8kHz (PCM) would be acceptable.

Note 14: Reserved bits should be set to zero when programming the associated register.

Voice Codec Configuration Register

This register configures the voiceband codec, sidetone attenuation, and selected control functions.

DEFAULT CHART FOR VOICE_CONFIG (01h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

VOICE_CONFIG (01h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Description							
3:0	SIDETONE_ATTEN	Programs the attenuat	ion of the digital sideto	one. Attenuation is set a	as follows:				
		3:0	Sidetone	3:0	Sidetone				
			Attenuation		Attenuation				
		0000	Mute	1000	-9dB				
		0001	-30dB	1001	-6dB				
		0010	-27dB	1010	-3dB				
		0011	-24dB	1011	0dB				
		0100	-21dB	1100	0dB				
		0101	-18dB	1101	0dB				
		0110	-15dB	1110	0dB				
		0111	-12dB	1111	0dB				
4	AUTO_SIDE	This will automatically	disable the sidetone v	when in a VOICE over I	oudspeaker mode				
		except when the head	phone is connected ar	nd the loudspeaker is m	nuted by the				
		HP_SENSE control.							
5	RSVD	RESERVED (Note 14)							
6	VADC_DITHER_OFF	Disables the Voice AD	Disables the Voice ADC dither.						
7	VDAC_DITHER_OFF	Disables the Voice DA	C dither.						

Microphone Gain Registers

This register is used to control the gain of the microphone preamplifier.

DEFAULT CHART FOR MIC_GAIN (02h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

MIC_GAIN (02h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Description				
3:0	MIC_GAIN	Programs the gain	of the microphone pre-amplifier. Gain is			
		set as follows:				
		3:0	Mic Gain			
		0000	6dB			
		0001	8dB			
		0010	10dB			
		0011	12dB			
		0100	14dB			
		0101	16dB			
		0110	18dB			
		0111	20dB			
		1000	22dB			
		1001	24dB			
		1010	26dB			
		1011	28dB			
		1100	30dB			
		1101	32dB			
		1110	34dB			
		1111	36dB			
4	MIC_MUTE	If set the microphor	ne pre-amplifier and the ADC output are			
		muted.				
5	RSVD	RESERVED (Note	14)			
6	RSVD	RESERVED (Note	14)			
7	HPF_DISABLE	If set the HPF is disabled, this is useful for wider bandwidth				
		use of the ADC.				

Headphone Gain Registers

This register is used to control the gain of the headphone amplifier.

DEFAULT CHART FOR HP_GAIN (03h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

HP_GAIN (03h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register		I	Description				
4:0	HP_GAIN	Programs the	gain of the headphone a	amplifier. Gain is	set as follows:			
		4:0	Headphone Gain	4:0	Headphone Gain			
		00000	-46.5dB	10000	-22.5dB			
		00001	-45dB	10001	-21dB			
		00010	-43.5dB	10010	-19.5dB			
		00011	-42dB	10011	-18dB			
		00100	-40.5dB	10100	-16.5dB			
		00101	-39dB	10101	-15dB			
		00110	-37.5dB	10110	-13.5dB			
		00111	-36dB	10111	-12dB			
		01000	-34.5dB	11000	-10.5dB			
		01001	-33dB	11001	-9dB			
		01010	-31.5dB	11010	-7.5dB			
		01011	-30dB	11011	-6dB			
		01100	-28.5dB	11100	-4.5dB			
		01101	-27dB	11101	-3dB			
		01110	-25.5dB	11110	-1.5dB			
		01111	-23dB	11111	0dB			
5	HP_MUTE	If set the head	lphone amplifier is muted	d.				
		Defines if a high	gh or low voltage at the	HP_SENSE pin	should indicate that a			
		headphone is	plugged in.					
6	HP SENSE TYPE	HP_S	SENSE_TYPE		HP_SENSE_IN			
0	TIF_SENSE_TTFE		0	Hi	gh = HP Plugged In			
			1	Lo	ow = HP Plugged In			
			The HP_SENSE_OUTPUT signal can be configured to appear on the GPIO pin.					
7	HP_SENSE_OUTPUT		•		the GPIO pin is reversed, so if			
		the headphone is connected a 0 is reported on the GPIO rather than a 1. This does not						
			·	auto-muting func	tion (as defined in Loudspeaker			
		Gain Register)						

Loudspeaker Gain Register

This register configures the loudspeaker amplifier gain and muting conditions.

DEFAULT CHART FOR LS_GAIN (04h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

LS_GAIN (04h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register		Desc	ription				
4:0	LS_GAIN	Programs the gain o	f the loudspeaker amp	lifier. Gain is set as foll	ows:			
		4:0	Loudspeaker Gain	4:0	Loudspeaker Gain			
		00000	-34.5dB	10000	-10.5dB			
		00001	-33dB	10001	-9dB			
		00010	-31.5dB	10010	-7.5dB			
		00011	-30dB	10011	-6dB			
		00100	-28.5dB	10100	-4.5dB			
		00101	-27dB	10101	-3dB			
		00110	-25.5dB	10110	-1.5dB			
		00111	-24.5dB	10111	0dB			
		01000	-22.5dB	11000	1.5dB			
		01001	-21.5dB	11001	3dB			
		01010	-19.5dB	11010	4.5dB			
		01011	-18dB	11011	6dB			
		01100	-16.5dB	11100	7.5dB			
		01101	-15dB	11101	9dB			
		01110	-13.5dB	11110	10.5dB			
		01111	-12dB	11111	12dB			
5	LS_MUTE	If set the loudspeake	er amplifier is muted.					
6	LS_AUTO_MUTE	If set the loudspeaker amplifier is automatically muted when the headphone sense						
		detects that the headphones have been connected. This uses the conditions set by						
		HP_SENSE_TYPE to determine if the headphones are connected.						
7	LS_PWDN		•	n external amplifier is b	eing used, an enable			
		signal can be access	sed on the GPIO.					

PLL Configuration Registers

This register is used to control the frequency divider (M divider) which sits before the PLL phase comparator, it also allows the 3 MSBs of the N_divider's modulus input to be programmed. **See Figure 4 for further explanation.**

DEFAULT CHART FOR PLL_M (05h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

PLL_M (05h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Description			
4:0	PLL_M	Programs the PLL input divider from divide by 4 to divide by 31. It is also			
		possible to bypass the divider if PLL_M = 1 or divide by 2 if PLL_M = 2. Setting			
		PLL_M = 3 will default to divide by 4.			
7:5	PLL_N_MOD1	Programs the modulus bits [4:2] of the PLL feedback divider .			

This register is used to control the integer of the PLL feedback divider (fractional N divider).

DEFAULT CHART FOR PLL_N (06h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

PLL_N (06n) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Description
6:0	PLL_N	Programs the PLL feedback divider from divide by 4 to divide by 127, PLL_N
		inputs from 0 to 3 are rounded to 4.
7	FAST_VCO	If set the VCO operates best at frequencies up to 100MHz, normally the VCO is
		tuned for outputs around 50MHz.

This register is used to control the PLL output divider (P divider), it also allows the 2 LSBs of the N divider's modulus input to be programmed.

DEFAULT CHART FOR PLL_P (07h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

PLL_P (07h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Description			
3:0	PLL_P	Programs the PLL output divider from divi	de by 4 to divide by 15, PLL_P inputs		
		from 0 to 3 are rounded to 4. It is recomm	nended that P = 4 to keep the VCO		
		around its nominal frequency of 50MHz.			
5:4	PLL_N_MOD2	Programs the PLL feedback divider modulus bits [1:0].			
7:6	DITHER_LEVEL	Programs the magnitude of the PLL dither level.			
		7:6	PLL Dither Level		
		00	32		
		01	16		
		10	48		
		11	0		

The N divider is a fractional divider as such:

 $N = PLL_N + (PLL_NMOD/32)$

If the Modulus input is zero then the N divider is simpler an integer N divider. The output from the PLL is determined by the following formula:

Fout = (Fin*N)/(PLL_M*PLL_P)

PLL Configuration Registers (Continued)

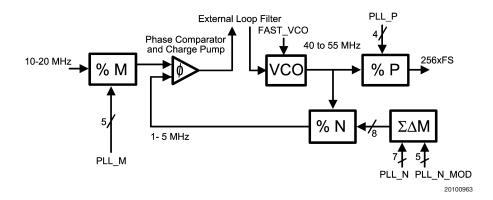


FIGURE 4.

AUDIO CLOCK REQUIREMENTS

Input Clock	Sample Rate	Required Clock	М	N	N_MOD	Р	Output Clock	Error (Hz)
12.000MHz	48kHz	12.288MHz	14	57	11	4	12.288MHz	0.2Hz
13.000MHz	48kHz	12.288MHz	4	15	4	4	12.288MHz	4.1Hz
14.400MHz	48kHz	12.288MHz	9	30	23	4	12.288MHz	1.9Hz
16.200MHz	48kHz	12.288MHz	11	33	12	4	12.288MHz	0.3Hz
16.800MHz	48kHz	12.288MHz	8	23	13	4	12.288MHz	1.1Hz
19.200MHz	48kHz	12.288MHz	13	33	9	4	12.288MHz	1.8Hz
19.440MHz	48kHz	12.288MHz	11	27	26	4	12.288MHz	0.3Hz
19.680MHz	48kHz	12.288MHz	13	32	15	4	12.288MHz	0.7Hz
19.800MHz	48kHz	12.288MHz	16	39	23	4	12.287MHz	0.1Hz
12.000MHz	44.1kHz	11.2896MHz	8	32	27	4	11.290MHz	1.7Hz
13.000MHz	44.1kHz	11.2896MHz	6	20	27	4	11.290MHz	2.9Hz
14.400MHz	44.1kHz	11.2896MHz	14	43	29	4	11.290MHz	2.3Hz
16.200MHz	44.1kHz	11.2896MHz	15	41	26	4	11.289MHz	0.9Hz
16.800MHz	44.1kHz	11.2896MHz	17	57	4	5	11.290MHz	1.6Hz
19.200MHz	44.1kHz	11.2896MHz	15	35	9	4	11.290MHz	0.8Hz
19.440MHz	44.1kHz	11.2896MHz	15	34	27	4	11.289MHz	1.6Hz
19.680MHz	44.1kHz	11.2896MHz	7	16	2	4	11.290MHz	0.2Hz
19.800MHz	44.1kHz	11.2896MHz	17	48	15	5	11.289MHz	3.0Hz
I ² S Inputs:								
1.536MHz	48kHz	12.288MHz	1	32	0	4	12.288MHz	0Hz
1.4112MHz	44.1kHz	11.2896MHz	1	32	0	4	11.2896MHz	0Hz
Other example	es:							
19.44MHz	32kHz	8.192MHz	17	50	5	4	8.193MHz	6Hz
24.576MHz	44.1kHz	11.2896MHz	14	26	11	4	11.2868MHz	2.3Hz
66MHz	48kHz	12.288MHz	12	17	28	4	12.288MHz	4.1Hz
100MHz	48kHz	12.288MHz	24	23	19	4	12.288MHz	1.6Hz
100MHz	44.1kHz	11.2896MHz	31	28	0	4	11.2899MHz	2.8Hz

Please note that the Error (Hz) column is relative to sample rate. For instance:

If the Sample Rate is 48kHz and the input clock is 12.000MHz, then the solution shown in the table is:

Output Clock = 12.000MHz * (57 + 11/32) / (14 * 4) = 12.287946MHz. = 47.99979kHz * 256

Error = 48kHz - 47.99979kHz = 0.2Hz

Clock Divider Configuration Registers

This register is used to control the multiplexers in the clock module.

DEFAULT CHART FOR CLK_MUX (08h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

CLK_MUX (08h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Descr	iption					
		Programs the PLL input multiplexer to s	Programs the PLL input multiplexer to select. (Note 12)					
0	DI I INDUT	PLL_INPUT	PLL Input Source					
0	PLL_INPUT	0	MCLK					
		1	I ² S Input Clock					
		If set the master clock is divided by two	o, for example allowing for a					
		24.576MHz or PCI clock to be used. (N	lote 12, 15)					
1	FAST_CLOCK	FAST_CLOCK	MCLK Frequency					
		0	Normal					
		1	Divided by 2					
		Selects which clock is passed to the au	udio sub-system: (Note 12)					
		AUDIO_CLK_SEL	Audio Sub-system					
2	AUDIO_CLK_SEL		Input Source					
		0	PLL Output					
		1	MCLK / MCLK/2					
		Selects which clock is passed to the voice sub-system: (Note 12)						
		VOICE_CLK_SEL	Audio Sub-system					
3	VOICE_CLK_SEL		Input Source					
		0	PLL Output					
		1	MCLK / MCLK/2					
4	PLL_DISABLE	Powers down the PLL if it is not require	ed.					
		Programs the Q divider (divides from the	ne PLL output frequency of					
		12.288MHz).						
		6:5	Divide Value					
6:5	Q_DIV	00	12 (1.024MHz/8kHz)					
		01	8 (1.536MHz/12kHz)					
		10	6 (2.048MHz/16kHz)					
		11	4 (3.072MHz/24kHz)					
7	RSVD	RESERVED (Note 14)						

Note 15: For inputs greater than 50Mhz, the input clock divider FAST_CLOCK should be set.

Clock Divider Configuration Registers (Continued)

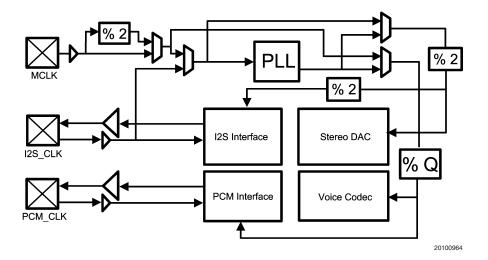


FIGURE 5.

The voice codec operates at 128*fs, so it requires a 1.024MHz clock to operate on 8kHz data. The Audio DAC also operates at 128*fs, i.e. 6.144MHz for 48kHz data, 5.6448MHz for 44.1kHz data etc. It is expected that the PLL is used to drive the audio system unless a 12.288MHz or 24.576MHz (AC'97) master clock is supplied and the sample rate is always 48kHz, in which case the PLL can be bypassed to reduce power.

The voice codec is always driven from the divided down clock from the PLL output or a divided down version of the master clock. When using the voice codec for 8kHz operation, program the PLL as you would for 48kHz operation and use Q to divide by (2*FSaudio/FSvoice).

The PLL can also use the I2S clock input as a source. In this case, the audio DAC uses the clock from the output of the PLL and the voice codec either uses a divided by 6 clock or a divided version of the MCLK pin.

MCLK must be less than or equal to 50MHz if the input divider is to be used, otherwise MCLK can be any frequency up to 25MHz. The comparison frequency after the M divider should be less than 5MHz

Digital Interface Configuration Registers

This register is used to control the format of the PCM, I2S, and GPIO interfaces.

DEFAULT CHART FOR INTERFACES (09h)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

INTERFACES (09h) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register	Descrip	tion	
		If set the data is assumed to be in either A-law or		
0	PCM COMPANDED	u-law 8-bit companded form,	otherwise it is assumed	
	TOW_COM ANDED	to be up to 16 bits of MSB file	rst linear 2's	
		complement PCM format. (N	ote 12)	
1	PCM_ALAW_ULAW	If set the data is assumed to	be A-law, otherwise it is	
		u-law companded. (Note 12)		
2	PCM_MS	When set the PCM operates in a master mode.		
3	PCM_LONG	When set the PCM operates in long mode. (Note		
4	I ² S_MS	When set the I ² S operates in a master mode.		
		This selects if each word is 16 or 32 bits long: (Note		
		16)		
		I ² S_RES	Word Length	
5	I ² S_RES	0	16	
		1	32	
		In 32 bit mode the 18 MSBs are passed to the DAC.		
		In 16 bit mode all 16 bits are	passed to the DAC.	
6	RSVD	RESERVED (Note 14)		
7	RSVD	RESERVED (Note 14)		

Note 16: Always operate the digital IO at the lowest frequency possible to save power and reduce noise. Obviously this can limit the resolution of the I²S interface from 18 bits to 16 bits, but if only 16 bit data is available use the 16 bit mode to reduce I/O power.

Power Management Configuration Registers

This register is used to control the power management settings.

DEFAULT CHART FOR PMC_CONFIG (0Ah)

DATA BIT	7	6	5	4	3	2	1	0
DEFAULT	0	0	0	0	0	0	0	0

PMC_CONFIG (0Ah) (SET = LOGIC 1, CLEAR = LOGIC 0)

Address	Register		Description				
0	ZXD_DISABLE	If set then zero cross degains. (Note 19)	If set then zero cross detection is ignored when changing modes or gains. (Note 19)				
		Set to accommodate a s turn-on delay and click/p 17)	* * * * * * * * * * * * * * * * * * * *				
	0.4.0.017.5	2:1	Delay	Capacitor Size/Time			
2:1	CAP_SIZE	00	short	0.1µF/25ms			
		01	medium	1μF/100ms			
		10	long	2.2µF/200ms			
		11	test	Test Mode/1ms			
		Set the GPIO port function: (Note 18)					
		5:3	GPIO				
		000	HP_C0	ONNECTED			
		001	VC.	_CLOCK			
5:3	GPIO_SETUP	010	GPI	O_DATA			
5.5	GFIO_SETUP	011	EXT_L	S_ENABLE			
		100	VOICE	E_ADC_SD			
		101	VOICE	E_DAC_SD			
		110	DAC_LEFT_SD				
		111	DAC_	RIGHT_SD			
6	RSVD	RESERVED (Note 14)	RESERVED (Note 14)				
7	CLASS_D_DITHER	When set enables dither	When set enables dither in the class D amplifier				

Note 17: The effect of CAP_SIZE will vary with the audio clock frequency. The delays quoted are for a 12.288MHz MCLK. These will scale inversely to the MCLK frequency. For example if used in a 44.1kHz application where the PLL output is 11.2896MHz, "01" or 100ms will be 100ms*11.2896/12.288 = 108.8ms. It is suggested that to save power earlier during the shutdown cycle, the PLL can be disabled and the MCLK or MCLK/2 can be used to bypass the PLL and also provide longer shutdown times for further reduced click and pop.

Note 18: VC_CLOCK is only supplied over the GPIO port if the voice codec is enabled.

Note 19: To ensure a successful transition into Powerdown Mode, ZXD_DISABLE must be set whenever there is no audio input signal present.

Audio Interfaces

I²S

The LM4931 supports both master and slave I2S transmission at either 16 or 32 bits per word at clock rates up to 3.072MHz (48kHz stereo, 32bit). The basic format is shown below:

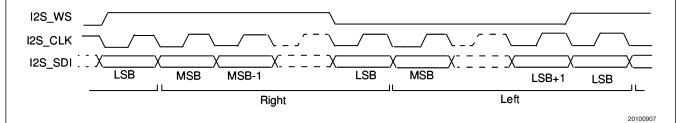
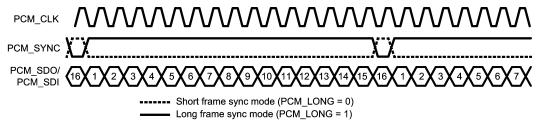


FIGURE 6.

PCM

The PCM interface is both master and slave and is compatible with National Semiconductor's AAI, Motorola's SSI, and Texas Instrument's McBSP audio codec interfaces. The protocol is short frame sync MSB first 2's complement 16 bit linear. The MSB always follows the sync pulse. In the case of companded data the first 8 bits are used and the interface can be slowed to 8 clock cycles per sync. In PCM_LONG mode the PCM_SYNC signal is inverted relative to that shown below.

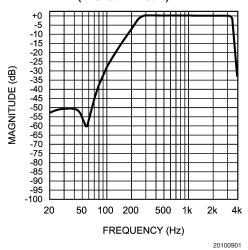


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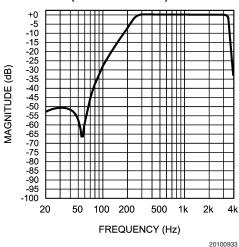
FIGURE 7.

Typical Performance Characteristics

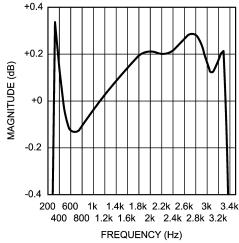
MIC PreAmp + ADC Frequency Response (MIC Gain = 6dB)



MIC PreAmp + ADC Frequency Response (MIC Gain = 36dB)

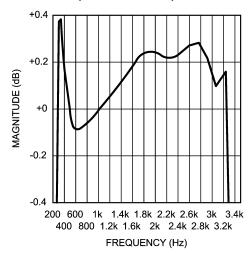


MIC PreAmp + ADC Frequency Response Zoom (MIC Gain = 6dB)



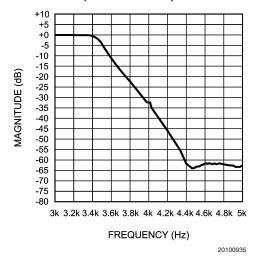
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MIC PreAmp + ADC Frequency Response Zoom (MIC Gain = 36dB)

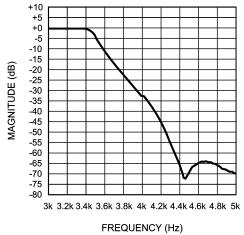


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MIC PreAmp + ADC Frequency Response High Cutoff (MIC Gain = 6dB)

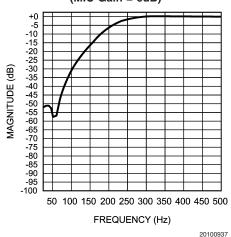


MIC PreAmp + ADC Frequency Response High Cutoff (MIC Gain = 36dB)

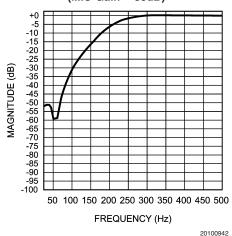


20100936

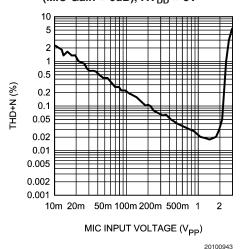
MIC PreAmp + ADC Frequency Response Low Cutoff (MIC Gain = 6dB)



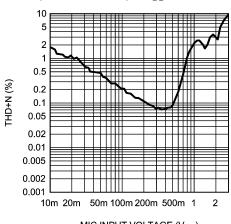
MIC PreAmp + ADC Frequency Response Low Cutoff (MIC Gain = 36dB)



ADC THD+N vs MIC Input Voltage (MIC Gain = 6dB), AV_{DD} = 5V

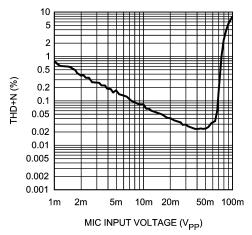


ADC THD+N vs MIC Input Voltage (MIC Gain = 6dB), AV_{DD} = 3V



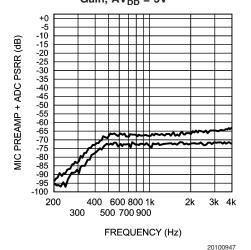
MIC INPUT VOLTAGE (V_{PP})

ADC THD+N vs MIC Input Voltage (MIC Gain = 36dB, AV_{DD} = 5V)

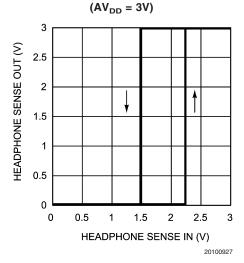


20100945

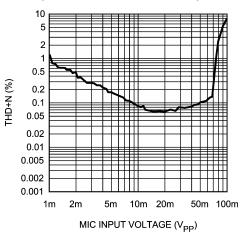
MIC PreAmp + ADC PSRR vs Frequency Top Trace = 36dB MIC Gain, Bottom Trace = 6dB MIC Gain, AV_{DD} = 5V



Headphone Sense In Hysteresis Loop

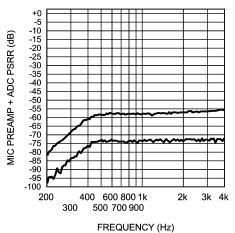


ADC THD+N vs MIC Input Voltage (MIC Gain = 36dB, AV_{DD} = 3V)



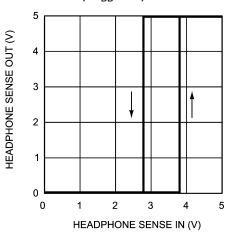
20100946

MIC PreAmp + ADC PSRR vs Frequency Top Trace = 36dB MIC Gain, Bottom Trace = 6dB MIC Gain, AV_{DD} = 3V

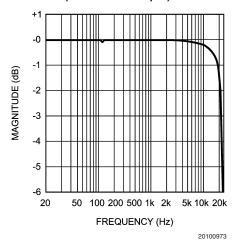


20100948

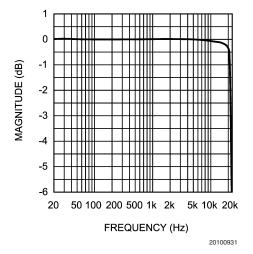
Headphone Sense In Hysteresis Loop $(AV_{DD} = 5V)$



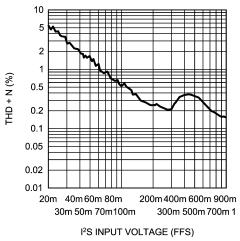
I²S DAC Frequency Response (Handsfree Output)



I²S DAC Frequency Response Zoom (Headphone Output)

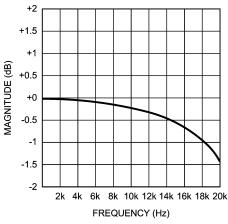


THD+N vs I²S Input Voltage (Handsfree Output, 0dB Handsfree Gain, AV_{DD} = 5V)



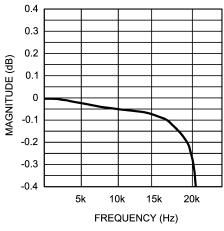
20100977

I²S DAC Frequency Response Zoom (Handsfree Output)

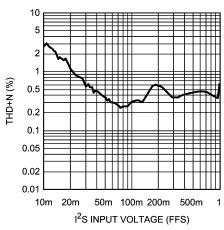


20100974

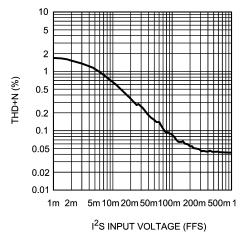
I²S DAC Frequency Response Zoom (Headphone Output)



THD+N vs I2S Input Voltage (Handsfree Output, 0dB Handsfree Gain, AV_{DD} = 3V)

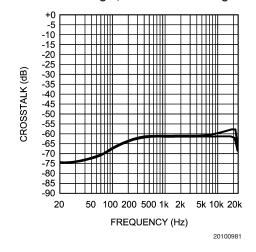


THD+N vs I 2 S Input Voltage (Headphone Output, 0dB Headphone Gain, AV_{DD} = 5V)

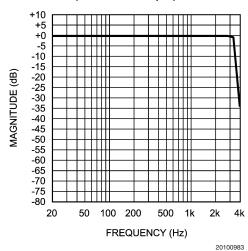


I²S DAC Crosstalk (Top Trace = Left to Right, Bottom Trace = Right to Left)

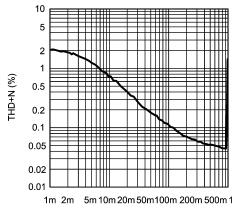
20100979



PCM DAC Frequency Response (Handsfree Output)



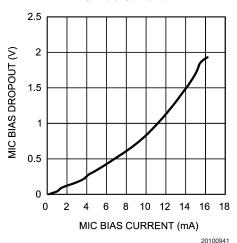
THD+N vs I 2 S Input Voltage (Headphone Output, 0dB Headphone Gain, AV $_{DD}$ = 3V)



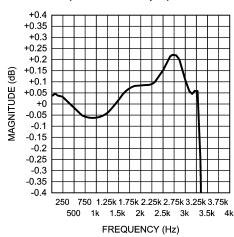
I²S INPUT VOLTAGE (FFS)

20100980

MIC Bias Dropout Voltage vs MIC Bias Current

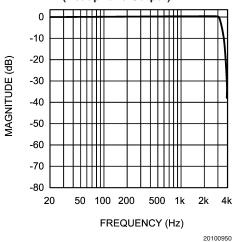


PCM DAC Frequency Response Zoom (Handsfree Output)

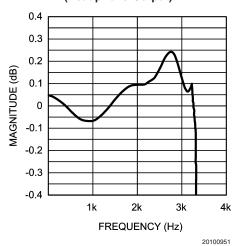


20100984

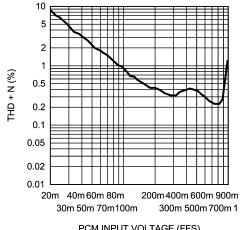
PCM DAC Frequency Response (Headphone Output)



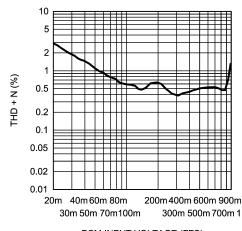
PCM DAC Frequency Response Zoom (Headphone Output)



THD+N vs PCM Input Voltage (Handsfree Output, 0dB Handsfree Gain, AV_{DD} = 5V)



THD+N vs PCM Input Voltage (Handsfree Output, 0dB Handsfree Gain, AV_{DD} = 3V)

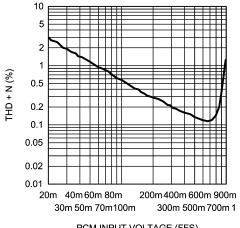


PCM INPUT VOLTAGE (FFS)

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PCM INPUT VOLTAGE (FFS) 20100988

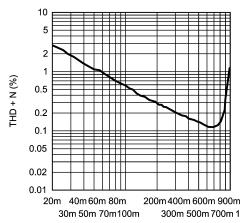
THD+N vs PCM Input Voltage (Headphone Output, 0dB Headphone Gain, AV_{DD} = 5V)



PCM INPUT VOLTAGE (FFS)

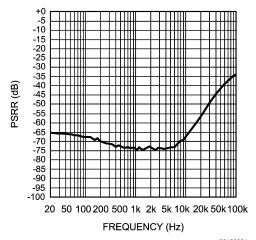
20100989

THD+N vs PCM Input Voltage (Headphone Output, 0dB Headphone Gain, AV_{DD} = 3V)

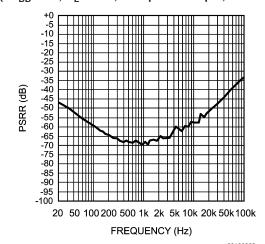


PCM INPUT VOLTAGE (FFS)

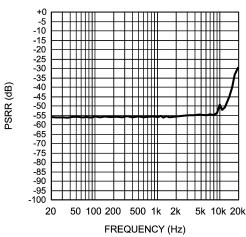
 $\label{eq:psr} \mbox{PSRR vs Frequency} \\ \mbox{(AV$_{DD}$ = 5V, R$_{L}$ = 32$$\Omega$, Headphone Output, Mode 6)}$



PSRR vs Frequency (AV $_{\rm DD}$ = 5V, R $_{\rm L}$ = 32 Ω , Headphone Output, Mode 7)

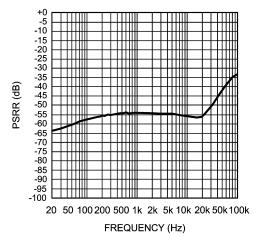


PSRR vs Frequency $({\rm AV_{DD}} = {\rm 5V},\,{\rm R_L} = {\rm 8\Omega},\,{\rm Handsfree~Output})$



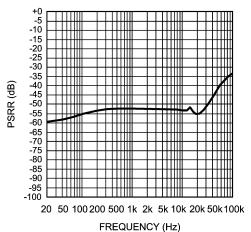
20100995

PSRR vs Frequency (AV_{DD} = 3V, R_L = 32Ω , Headphone Output, Mode 6)



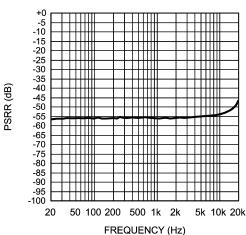
20100992

PSRR vs Frequency (AV $_{\rm DD}$ = 3V, R $_{\rm L}$ = 32 Ω , Headphone Output, Mode 7)



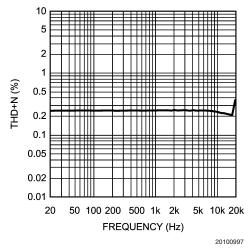
20100994

 $\label{eq:psr} \text{PSRR vs Frequency}$ (AV_DD = 3V, R_L = 8\$\Omega\$, Handsfree Output)

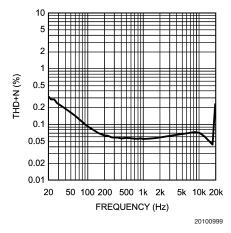


20100996

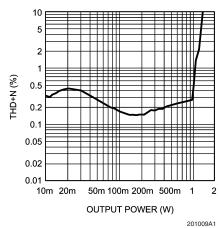
THD+N vs Frequency (AV $_{\rm DD}$ = 5V, R $_{\rm L}$ = 8 $\Omega,$ P $_{\rm O}$ = 400mW, Handsfree Output)



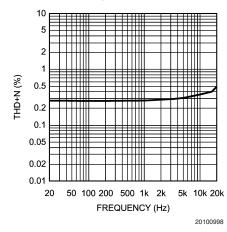
THD+N vs Frequency (AV $_{\rm DD}$ = 5V, R $_{\rm L}$ = 32 $\Omega,$ P $_{\rm O}$ = 7.5mW, Headphone Output)



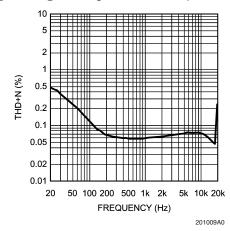
THD+N vs Output Power (AV_{DD} = 5V, R_L = 8 Ω , f = 1kHz, Handsfree Output)



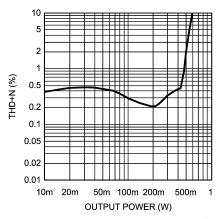
THD+N vs Frequency (AV $_{\rm DD}$ = 3V, R $_{\rm L}$ = 32 $\Omega,$ P $_{\rm O}$ = 200mW, Handsfree Output)



THD+N vs Frequency (AV $_{\rm DD}$ = 3V, R $_{\rm L}$ = 8 $\Omega,$ P $_{\rm O}$ = 7.5mW, Headphone Output)

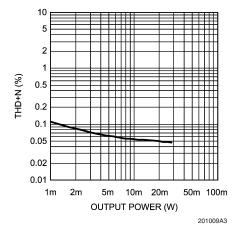


THD+N vs Output Power (AV_{DD} = 3V, R_L = 8 Ω , f = 1kHz, Handsfree Output)

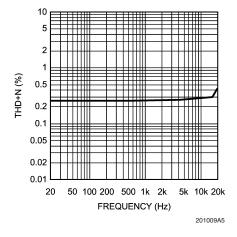


201009A2

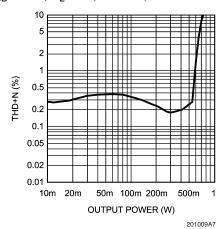
THD+N vs Output Power (AV_{DD} = 5V, R_L = 32 Ω , f = 1kHz, Headphone Output)



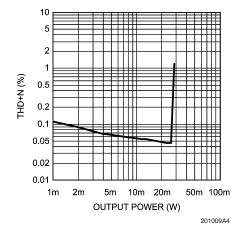
THD+N vs Frequency (AV_{DD} = 3.3V, R_L = 8Ω , P_O = 200mW, Handsfree Output)



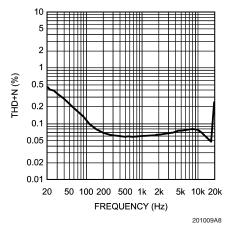
THD+N vs Output Power (AV $_{\rm DD}$ = 3.3V, R $_{\rm L}$ = 8 Ω , f = 1kHz, Handsfree Output)



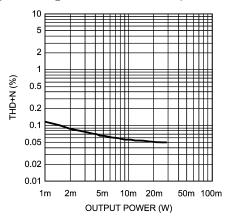
THD+N vs Output Power (AV $_{DD}$ = 3V, R $_{L}$ = 32 Ω , f = 1kHz, Headphone Output)



THD+N vs Frequency (AV $_{\rm DD}$ = 3.3V, R $_{\rm L}$ = 32 Ω , P $_{\rm O}$ = 7.5mW, Headphone Output)



THD+N vs Output Power (AV $_{DD}$ = 3.3V, R $_{L}$ = 32 Ω , f = 1kHz, Headphone Output)



201009A6

Application Information

REFERENCE DESIGN BOARD AND LAYOUT

LM4931ITL Board Layout

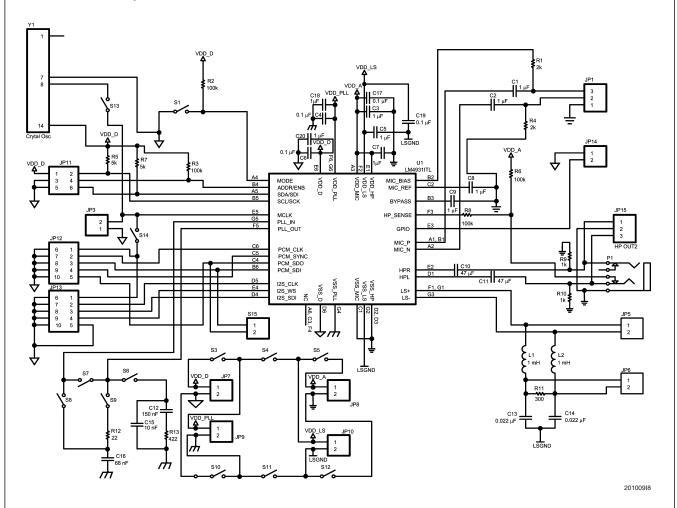


FIGURE 8. LM4931ITL Demo Board Schematic

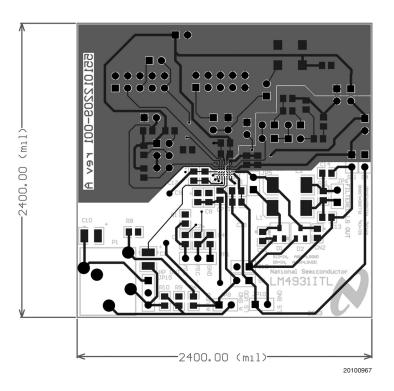


FIGURE 9. LM4931ITL Demo Board Composite View

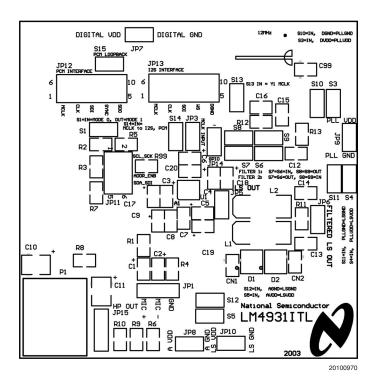


FIGURE 10. LM4931ITL Demo Board Silkscreen

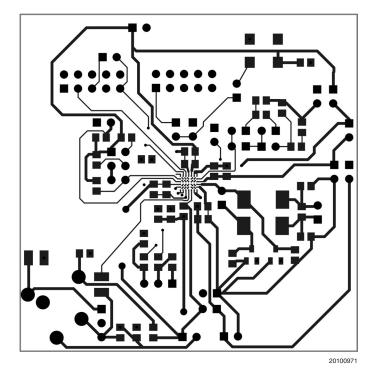


FIGURE 11. LM4931ITL Demo Board Top Layer

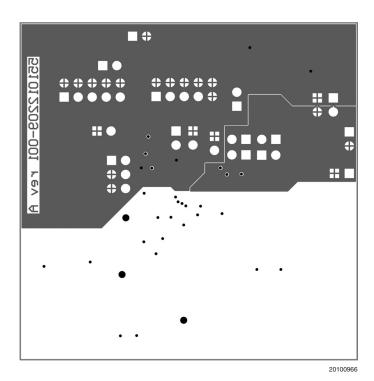


FIGURE 12. LM4931ITL Demo Board Bottom Layer

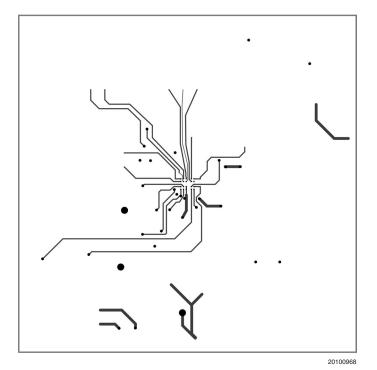


FIGURE 13. LM4931ITL Demo Board Inner Layer 1

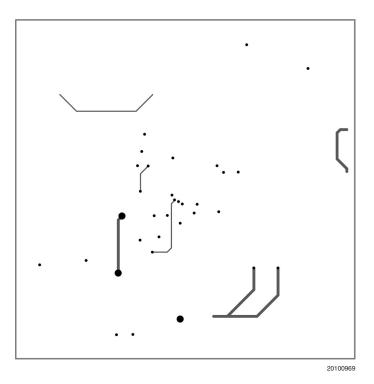


FIGURE 14. LM4931ITL Demo Board Inner Layer 2

LM4931 DEMO BOARD BILL OF MATERIALS

Part Description	QTY	Reference Designator
Cer Cap 10nF 50V 10% 0805	1	C15
Cer Cap 150nF 50V 10% 0805	1	C12
Cer Cap 68pF 50V 10% 0805	1	C16
Cer Cap 0.022uF 50V 10% 0805	2	C13, C14
Cer Cap 0.1uF 50V 10% 0805	4	C4, C6, C17, C19
Tant Cap 1uF 16V 10% Case=A 3216	9	C1-C3, C5, C7-C9, C18, C20
Tant Cap 47uF 16V 10% Case=C 6032	2	C10-C11
Res 22.6 ohm 1/10W 1% 0805	1	R12
Res 300 ohm 1/10W 1% 0805	1	R11
Res 422 ohm 1/10W 1% 0805	1	R13
Res 1K Ohm 1/10W 1% 0805	2	R9, R10
Res 2K Ohm 1/10W 1% 0805	2	R1, R4
Res 5K Ohm 1/10W 1% 0805	4	R2, R6, R8, R99
Inductor 1mH	2	L1, L2
Stereo Headphone Jack	1	P1
Header 1 X 2	22	JP3, JP5-JP10, Jp14, S1, S3-S15
Header 1 X 3	4	
Header 1 X 5	4	

I²C/SPI CONTROL INTERFACE (JP11)

Pin	Function
1	VDD_D
2	SCL/SCK
3	VSS_D
4	ADDR/ENB
5	VSS_D
6	SDA/SDI

PCM INTERFACE (JP12)

Pin	Function
1	MCLK
2	PCM_CLK
3	PCM_SDI
4	PCM_SYNC
5	PCM_SDO
6	VSS_D
7	VSS_D
8	VSS_D
9	VSS_D
10	VSS_D

I²S INTERFACE (JP13)

Pin	Function
1	MCLK
2	I2S_CLK
3	I2S_SDI
4	12S_WS

I²S INTERFACE (JP13) (Continued)

5	VSS_D
6	VSS_D
7	VSS_D
8	VSS_D
9	VSS_D
10	VSS_D

MIC JACK (JP1)

Pin	Function
1	VSS_HP
2	MIC_N
3	MIC_P

EXTERNAL MASTER CLOCK INPUT MCLK/XTAL (JP3)

Pin	Function
1	VSS_D
2	MCLK

DIGITAL SUPPLY VOLTAGE AND (JP7)

Pin	Function
1	VDD_D
2	VSS_D

PLL SUPPLY VOLTAGE AND GND (JP9)

Pin	Function
1	VDD_PLL
2	VSS_PLL

ANALOG SUPPLY VOLTAGE AND GND MIC AND HEADPHONE (JP8)

Pin	Function
1	VDD_A
2	VSS_A

ANALOG SUPPLY VOLTAGE AND GND FOR LOUDSPEAKER (JP10)

Pin	Function
1	VDD_LS
2	VSS_LS

ALTERNATE STEREO HEADPHONE OUTPUT (JP15)

Pin	Function
1	HPR
2	VSS_HP
3	HPL

LOUDSPEAKER DIRECT OUTPUT (JP5)

Pin	Function
1	LS+
2	LS-

LOUDSPEAKER FILTERED OUTPUT — FOR MEASUREMENT PURPOSES (JP6)

Pin	Function
1	Filtered LS+
2	Filtered LS-

MULTI-USE PORT GPIO (JP14)

Pin	Function
1	VSS_D
2	GPIO

PCM LOOPBACK JUMPER

Pin	Function
1	PCM_SDI
2	PCM_SDO

MODE Select Jumper (S1)

Jumper IN = LOW Jumper OUT = HIGH

Crystal MCLK Jumper (S13)

Jumper IN = MCLK Supplied by on-board crystal oscillator

Jumper OUT = MCLK supplied by other source, crystal oscillator isolated

MCLK to PCM Bus and I²S Bus Jumper (S14)

Jumper IN = MCLK connected to PCM bus and I^2S bus Jumper OUT = MCLK isolated from PCM bus and I^2S bus

PLL FILTER SELECT JUMPERS (S6-S9)

Jumper	IN/OUT	Function
S6 + S7	IN	2nd Order Filter Select
S8 + S9	OUT	
S6 + S7	OUT	3rd Order Filter Select
S8 + S9	IN	

POWER SUPPLY JUMPERS (S3-S5, S10-S12)

Jumper	Function
S3	connects VDD_D and VDD_PLL
S4	connects VDD_PLL and VDD_LS
S5	connects VDD_A and VDD_LS
S10	connects VSS_D and VSS_PLL
S11	connects VSS_PLL and LSGND
S12	connects VSS_A and LSGND

LM4931ITL DEMO BOARD OPERATION

The LM4931ITL demo board is a complete evaluation platform, designed to give easy access to the control pins of the part and comprises all the necessary external passive components. Besides the separate analog (JP8), digital (JP7), PLL (JP9) and Loudspeaker (JP10) supply connectors, the board features seven other major input and control blocks: an SPI/I²C compatible selectable interface bus (JP11) for the control lines, a PCM interface bus (JP12) for voiceband digital audio, an I²S interface bus (JP13) for full-range digital audio, an analog mic jack input (JP1) for connection to an external microphone, a high efficiency class D BTL mono output (JP5) for connection to an external speaker, a stereo headphone output (JP15 or P1), and an external MCLK input (JP3) for use in place of the crystal on the demoboard.

SPI/I²C Interface Bus (JP11)

This is the main control bus for the LM4931. This interface may either be configured as a two-wire, I^2C compatible interface by setting MODE = 0 (S1 = IN) or a three-wire SPI interface by setting MODE = 1 (S1 = OUT).

I^2C Compatible Mode (MODE = 0)

The two-wire I2C compatible interface consists of an SDA line (data) and SCL line (clock). Each transmission from the baseband controller to the LM4931 is given MSB first and must follow the timing intervals given in the Electrical Characteristics section of the datasheet to create the start and stop conditions for a proper transmission. The start condition is detected if SCL is high on the falling edge of SDA. The stop condition is detected if SCL is high on the rising edge of SDA. Repeated start signals are handled correctly. Data is then transmitted as shown in Figure 3 for the Two Wire I2C Compatible Interface. After the start condition has been achieved the chip address is sent, followed by a set write bit, wait for ack (SDA will be pulled low by LM4931), data bits 15-8, wait for ACK (SDA will be pulled low by LM4931), data bits 7-0, wait for ACK (SDA will be pulled low by LM4931) and finally the stop condition is given.

This same sequence follows for any I²C control bus transmission to the LM4931. The chip address is hardwire selected by the ADDR Select pin (JP11, pin 4) which may be software enabled high or low with the LM4931 demonstration control software. If ADDR is low, then the chip address is set to 0010000b. If ADDR is high, the address is set to 1110000b. The 11 control registers are shown on page 13 in the **System Control Table**. Data is sampled only if the address is in range and the R/W bit is clear. Data for each register is given in the **System Control** section of the datasheet.

Pull-up resistors are required to achieve reliable operation. $10k\Omega$ pull-up resistors on the SDA and SCL lines achieves best results when used with National's parallel-to-serial interface board. Lower value pull-up resistors will decrease the rise and fall times on the bus which will in turn decrease susceptibility to bus noise that may cause a false trigger. The cost comes at extra current use. Control bus reliability will thus depend largely on bus noise and may vary from design to design. Low noise is critical for reliable operation.

SPI Mode (MODE = 1)

The SPI interface consists of three lines: the serial data input pin (SDI), the clock input pin (SCK), and the SPI enable pin (ENB). The serial data bits are organized into two fields of 8

bit data as shown on Figure 2 in the Three Wire, SPI Interface timing diagram. The first 8 bits corresponds to the register address given on the System Control Table on page 13. The second 8 bits contains the data to write to the desired control register. These fields are transmitted subsequently to form a 16 bit word. For each SPI transfer, ENB is lowered and the data bits are written to the SDI pin with the most significant bit (MSB) first. All serial data are sampled at the rising edge of the SCK signal. Once all the data bits have been sampled, ENB transitions from logic-high to logic-low to complete the SPI sequence. All 16 bits must be received before any data latch can occur. Any excess CLK and DATA transitions will be ignored after the sixteenth rising clock edge has occurred. For any data sequence longer than 16 bits, only the first 16 bits will get loaded into the shift register and the rest of the bits will be disregarded.

SPI Operational Requirements

- 1. The data bits are transmitted with the MSB first.
- 2. The maximum clock rate is 4MHz for the SCK pin.
- 3. SCK must remain logic-high for at least 500ns ($t_{\rm SPICH}$) after the rising edge of SCK, and SCK must remain logic-low for at least 500ns ($t_{\rm SPICL}$) after the falling edge of SCK.
- 4. The serial data bits are sampled at the rising edge of SCK. Any transition on SDI must occur at least 100ns ($t_{\rm SPISETHOLDD}$) before the rising edge of SCK. Also, any transition on SDI must occur at least 100ns ($t_{\rm SPISETD}$) after the rising edge of SCK and stabilize before the next rising edge of SCK.
- ENB should be logic-low only during serial data transmission.
- 6. ENB must be logic-low at least 100ns ($t_{\rm SPISETENB}$) before the first rising edge of SCK, and ENB has to remain logic-low at least 100ns ($t_{\rm SPIHOLDENB}$) after the sixteenth rising edge of SCK.
- 7. If ENB remains logic-high for mtore than 10ns before all 16 bits are transmitted then the data latch will be aborted.
- 8. If ENB is logic-low for more than 16 SCK pulses then only the first 16 data bits will be latched and activated when ENB transitions to logic-high.
- 9. ENB must remain logic-low for at least 100ns ($t_{\text{SPIHOLD-ENB}}$) to latch in the data.
- 10. Coincidental rising or falling edges of SCK and ENB are not allowed. If SCK is to be held logic-high after the data transmission, the falling edge of SCK must occur at least 100ns before ENB transitions to logic-low for the next set of data.

LM4931 Evaluation Software

The LM4931 demoboard can be easily evaluated with the accompanying **LM4931 Evaluation Software**. The Windows 95/98/2000/NT/XP compatible software is a GUI that allows easy access to all the I²C/SPI internal registers of the device. The GUI controls the PC parallel port to deliver the appropriate I²C/SPI commands via the National Semiconductor I²C/SPI Interface Card, in order to properly program the LM4931.

PCM Bus Interface (JP12)

PCM_SDO, PCM_SYNC, PCM_SDI, and PCM_CLK form the PCM interface bus for simple communication with most baseband ICs with voiceband communications and follow the PCM-1900 communications standard. The PCM interface features a frame length of 16 bits, A-law and u-law companded, linear mode, short or long frame sync, an

energy-saving power down mode, and master or slave operation. PCM_SYNC is the word sync line for the bus. It may be set in the INTERFACES (09h) register (bit 3 PCM_LONG) for short or long frame sync. A short frame sync is 1 PCM_CLK cycle (PCM_LONG=0), a long frame sync is an inverted version of short sync (PCM_LONG=1). This is illustrated by Figure 7 in the PCM timing diagram under the Audio Interfaces section. PCM_CLK is the bit clock for the bus. Its frequency is fixed at 128kHz and may be generated by the LM4931 when the PCM section is set to operate in master mode by setting bit 2 of the INTERFACES (09h) register. Clearing this same bit (bit 2) places the PCM section into slave mode where an external clock must be provided

The other two lines, PCM_SDO and PCM_SDI, are for serial data out and serial data in, respectively. The type of data may also be set in the <code>INTERFACES</code> (09h) register by bits 0 and 1. Bit 0 controls whether the data is linear or companded. If set to 1, the 8 MSBs are presumed to be companded data and the 8 LSBs are ignored. If cleared to 0, the data is treated as 2's complement PCM data. Bit 1 controls which PCM law is used if Bit 0 is set for companded (G711) data. If set to 1, the companded data is assumed to be A-law. If cleared to 0, the companded data is treated as μ -law.

I²S Interface Bus (JP13)

The I²S standard provides a uni-directional serial interface designed specifically for digital audio. For the LM4931, the interface provides access to a 48kHz, 18 bit full-range stereo audio DAC. This interface uses a three port system of clock (I²S_CLK), data (I²S_SDI), and word (I²S_WS). The clock and word lines can be either master or slave as set by bit 4 in the INTERFACES (09h) register.

A bit clock (I²S_CLK) at 32 or 64 times the sample frequency is generated by the I²S system master (unless set as a slave) and a word select (I²S_WS) line is driven at a frequency equal to the sampling rate of the audio data, up to 48kHz. The word length is set by bit 5 of the **INTERFACES** (09h) register. When bit 5 is cleared, a word length of 16 bits is selected. When set, the word length is set to 32 bits. All 18MSBs are passed to the DAC when the I²S interface is set to 32 bit word mode. In 16 bit mode, all 16 bits are sent to the DAC. The word line is registered to change on the negative edge of the bit clock. The serial data (I²S_SDI) is sent MSB first, again registered on the negative edge of the bit clock, delayed by 1 bit clock cycle relative to the changing of the word line (see **Figure 6**).

MCLK/XTAL_IN (JP3)

This is the input for an external Master Clock. The jumper at S13 must be removed (disconnecting the onboard crystal from the circuit) when using an external Master Clock. Additionally, the jumper S14 may be used to connect the MCLK with the PCM and I²S interface buses.

High-Efficiency Class D BTL Mono Out (JP5)

This is the high-efficiency mono speaker output, designed for use with an 8Ω speaker. The outputs are driven in bridgetied-load (BTL) mode, so both sides have signal. Outputs are normally biased at one half AV_{DD} when the LM4931 is in active mode. The class D amplifier provides exceptional power use savings versus standard class AB amplifiers. A measurement output (JP6) is also provided, since the switching characteristics of an unfiltered Class D output

often render conventional audio measurement techniques useless. This output band-limits the output to 20kHz, filtering out the switching noise for measurement purposes. This measurement output is not intended to provide power to a load.

Stereo Headphone Out (JP15 or P1)

This is the stereo headphone output. Each channel is singleended, with 47uF DC blocking capacitors mounted on the demo board. The jack (P1) features a typical stereo headphone pinout. An alternate, pinned connection is also provided (JP15).

Headphone sense is incorporated into the jack on the demo board. In this application HP_SENSE is pulled low by the $1k\Omega$ resistor when no headphone is present. This gives a corresponding logic low output on the HP_SENSE pin. When a headphone is placed in the jack the $1k\Omega$ pull-down is disconnected and a $100k\Omega$ pull-up resistor creates a high voltage condition on HP_SENSE. This information may be placed on the GPIO pin to reliably drive an external microcontroller with headphone status.

It is important to note that if using the alternate connection (JP15) for stereo headphone operation, HP sense is still tied to the mini-jack, requiring a physical plug to break the connection. HP sensing will then require a plug be placed in the jack (dummy plug).

MIC Jack (JP1)

This jack is for connection to an external microphone like the kind typically found in mobile phones. Pin 1 is GND, pin 2 is the negative input pin, and pin 3 is the positive pin, with phantom voltage supplied by MIC_BIAS on the LM4931.

GPIO (JP14)

This pin provides simple status updates from the LM4931 to an external microcontroller if desired. The GPIO output may be configured in the PMC_CONFIG (0Ah) register. Bits of the PMC_CONFIG (0Ah) register may be used to set the GPIO to output information regarding whether the headphone is connected, the voice-codec clock, an external LS enable signal, and shutdown status for the voiceband ADC, voiceband DAC, and the Left and Right channels of the full range-audio DAC. The voice-codec clock is only provided over the GPIO port if the voice codec is enabled. These outputs can be useful for simple software/driver development to monitor mode changes, or as a simple debugging tool.

BASIC OPERATION

The LM4931 is a highly integrated audio subsystem with many different operating modes available. These modes may be controlled in the BASIC_CONFIG (00h) register by bits 3:0. These mode settings are shown in the BASIC_CONFIG (00h) register table and are described here below:

Powerdown Mode (0000b)

Part is powered down, analog outputs are not biased. This is a minimum current mode. All part features are shut down.

Standby Mode (0001b)

The LM4931 is powered down, but outputs are still biased at one half ${\rm AV_{DD}}$. This comes at some current cost, but provides a much faster turn-on time with zero "click and pop" transients on the headphone out. Standby mode can be

toggled into and out of rapidly and is ideal for saving power whenever continuous audio is not a requirement. All other part functions are suspended.

Mono Speaker Mode (0010b)

Part is active. All analog outputs are biased. Audio from the voiceband codec is routed to the mono speaker out. Stereo headphone out is muted.

Headphone Call Mode (0011b)

Part is active. All analog outputs are biased. Audio from voiceband codec is routed to the stereo headphones. Both left and right channels are the same. Mono speaker out is muted.

Conference Call Mode (0100b)

Part is active. All analog outputs are biased. Audio from the voiceband codec is routed to the mono speaker out and to the stereo headphones.

L+R Mixed to Mono Speaker (0101b)

Part is active. All analog outputs are biased. Full-range audio from the 18bit/48kHz audio DAC is mixed together and routed to the mono speaker out. Stereo headphones are muted.

Headphone Stereo Audio (0110b)

Part is active. All analog outputs are biased. Full-range audio from the 18bit/48kHz audio DAC is sent to the stereo headphone jack. Each channel is heard discretely. The mono speaker is muted.

L+R Mixed to Mono Speaker + Stereo Headphone Audio (0111b)

Part is active. All analog outputs are biased. Full-range audio from the 18bit/48kHz audio DAC is sent discretely to the stereo headphone jack and also mixed together and sent to the mono speaker out.

Mixed Mode (1000b)

Part is active. All analog outputs are biased. This provides one channel (the left channel) of full range audio to the mono speaker out. Audio from the voiceband codec is then sent to the stereo headphones, the same on each channel.

Mixed Mode (1001b)

Part is active. All analog outputs are biased. Mixed voiceband and full-range audio (left channel only) is sent to the mono speaker out. Audio from the voiceband codec only is sent to the stereo headphones, the same on each channel.

Mixed Mode (1010b)

Part is active. All analog outputs are biased. Audio from the voiceband codec is sent to the mono speaker out. The left channel only of the full range audio is then sent to both the left and right channels of the stereo headphone out.

REGISTERS

The LM4931 starts on power-up with all registers cleared in Powerdown mode. Powerdown mode is the recommended time to make setup changes to the digital interfaces (PCM bus, I²S bus). Although the configuration registers can be changed in any mode, changes made during Standby or

Powerdown prevent unwanted audio artifacts that may occur during rapid mode changes with the outputs active. The LM4931 also features a soft reset. This reset is enabled by setting bit 4 of the **BASIC_CONFIG (00h)** register. DAC dither may also be controlled in this register (bit 5).

The VOICE_CONFIG (01h) register is used to set various configuration parameters on the voiceband and full-range audio codecs. SIDETONE_ATTEN (bits 3:0) refers to the level of signal from the MIC input that is fed back into the analog audio output path (commonly used in headphone applications and killed in hands-free applications). Setting the AUTOSIDE bit (bit 4) automatically mutes the sidetone in voice over mono speaker modes so feedback isn't an issue. Dither for the voice ADC and DAC may be disabled by setting bits 6 or 7, respectively. Bit 5 is reserved.

The MIC_GAIN (02h) register provides for microphone preamplifier gains of 6dB to 36dB in 2dB steps (bits 3:0). A quick mute bit is provided for the mic (bit 4) as well as a bit to disable the high-pass filter on the voice ADC, allowing wider bandwidth usage through the microphone input.

The HP_GAIN (03h) register provides settings for headphone control. Bits 4:0 set the gain of the headphone output from –46.5dB to 0dB in 1.5dB steps. A quick mute bit is also provided (bit 5). Additionally, the LM4931 may be configured to react to a high or low HP_SENSE voltage (bit 6) and may also provide this output on the GPIO pin in either positive or negative form (bit 7). This will only be seen on the GPIO output if it is configured to show HP_CONNECTED as described in the GPIO section.

The **LS_GAIN (04h)** register is used to set the mono class D loudspeaker gain. Bits 4:0 set this from -34.5dB to +12dB in 1.5dB steps. A quick mute (bit 5) is provided as well as an auto-mute bit (bit 6) that, if set, automatically mutes the loudspeaker when headphone sense detects that headphones have been connected. A powerdown bit (bit 7) is also provided to independently shutdown just the class D amplifier.

CLK_MUX (08h) is the clock divider register. Bit 0 sets the PLL input source. When clear, MCLK is used, when set, the I²S input clock is used. Bit 1 gives a divide by 2 for usage with a faster MCLK (like 24.576MHz). Bit 2 selects which clock is passed to the full range audio subsystem. If clear, the PLL output is used. If set, MCLK (or MCLK/2 if set) is used directly. Bit 3 does the same for the voice codec subsystem. If clear, the PLL output is used. If set, MCLK or MCLK/2 is used. Bit 4 powers down the PLL (if not needed). Bits 6:5 program the Q divider, that can be further used to divide down the PLL output frequency. Bit 7 is reserved.

The INTERFACES (09h) register controls all the digital interface configurations. This may be used to set the PCM configuration and I²S configuration as stated above in the PCM Bus Interface and I²S Bus Interface sections. Bits 6 is reserved for test modes.

The PMC_CONFIG (0Ah) register controls various power management responsibilities including bypass capacitor size (bits 2:1). Zero crossing disable (bit 0) is also provided to allow the LM4931 to change modes regardless of zero crossing detect status. If set, the LM4931 will change modes immediately without waiting for the outputs to cross zero. Bits 6 is reserved.

PLL Registers

The PLL will accept incoming clock frequencies from 10MHz to 25MHz. However, since the control clocks, PCM clocks, and I²S clocks all operate at fixed, defined frequencies the

PLL must also be configured to match the incoming frequency and provide the correct output for all the parts of the subsystem.

The first register, **PLL_M** (05h), sets the PLL input divider. Bits 4:0 of this register are used to set the divider from 4 to 31. It is also possible to bypass the divider (M =1) by setting PLL_M to 0001b. Setting PLL_M to 0010b gives a divide by 2. Setting PLL_M to 0011b gives a default divider of 4 (as does setting to 0100b). Values above that are identical to their base 10 integer values. Bits 7:5 programs the modulus bits of the PLL feedback divider.

The second PLL register, **PLL_N** (06h), sets the PLL feedback divider. Bits 6:0 are used to set the PLL feedback divider from divide by 4 to divide by 127. Values set from 0 to 3 are rounded to 4. This register also may be used to alter the speed of the VCO. Setting bit 7 (FAST_VCO) tunes the VCO operation for frequencies up to 100MHz. Normally it is tuned for outputs around 50MHz.

The final PLL register, **PLL_P** (07h), sets the PLL output divider. Bits 3:0 set this from divide by 4 to divide by 15. Inputs of 0 to 3 are rounded to 4. It is also recommended that P = 4 to keep the VCO around its nominal operating frequency (50MHz if PLL_N bit 7 is clear). The divider modulus may be set by bits 5:4. Additionally, the dither level for the PLL is controlled in this register in bits 7:6.

The **Audio Clock Requirements** table details how different clock values may be generated for a given input clock.

PLL Loop Filter

The LM4931 demoboard features an onboard second and third order PLL loop filter. Jumpers (S6-S9) configure the demoboard to select between the second and third order PLL loop filters. Reference values for the loop filters are given in the **LM4931 Demo Board Bill of Materials** section. For a more detailed discussion on how to optimize a second and third order PLL loop filter, please refer to **Note 20**.

Note 20: http://www.national.com/appinfo/wireless/files/DeansBook_4_01.pdf.

ANALOG INPUTS AND OUTPUTS

The LM4931 features a high-efficiency class D mono BTL output for connection to an 8Ω external speaker. This output can provide up to 1.1W of power into an 8 ohms load with a 5V analog supply. A single-ended stereo headphone output is also featured, providing up to 26mW of power per channel into 32Ω with a 5V analog supply. The MIC Jack input (JP1) provides for a low level analog input. Pin 3 provides the power to the MIC and the positive input of the LM4931. Gain for the MIC preamp is set in the **MIC_GAIN (02h)** register.

HIGH EFFICIENCY CLASS D AMPLIFIER FUNCTION

The class D mono output signals generated by the LM4931 consist of two, BTL connected, output signals that pulse

momentarily from near ground potential to VDD. The two outputs can pulse independently with the exception that they both may never pulse simultaneously as this would result in zero volts across the BTL load. The minimum width of each pulse is approximately 160ns. However, pulses on the same output can occur sequentially, in which case they are concatenated and appear as a single wider pulse to achieve an effective 100% duty cycle. This results in maximum audio output power for a given supply voltage and load impedance. The LM4931 can achieve much higher efficiencies than class AB amplifiers while maintaining acceptable THD performance. The short (160ns) drive pulses emitted at the LM4931 outputs means that good efficiency can be obtained with minimal load inductance. The typical transducer load on an audio amplifier is quite reactive (inductive). For this reason, the load can act as it's own filter, so to speak. This "filter-less" switching amplifier/transducer load combination is much more attractive economically due to savings in board space and external component cost by eliminating the need for a filter.

CLASS D POWER DISSIPATION AND EFFICIENCY

In general terms, efficiency is considered to be the ratio of useful work output divided by the total energy required to produce it with the difference being the power dissipated, typically, in the IC. The key here is "useful" work. For audio systems, the energy delivered in the audible bands is considered useful including the distortion products of the input signal. Sub-sonic (DC) and super-sonic components (>22kHz) are not useful. The difference between the power flowing from the power supply and the audio band power being transduced is dissipated in the LM4931 and in the transducer load. The amount of power dissipation in the LM4931 is very low. This is because the ON resistance of the switches used to form the output waveforms is typically less than 0.25Ω . This leaves only the transducer load as a potential "sink" for the small excess of input power over audio band output power. The LM4931 dissipates only a fraction of the excess power requiring no additional PCB area or copper plane to act as a heat sink.

DUAL MICROPHONE SUPPORT

The LM4931 can be configured to accept two separate microphone inputs when used in conjunction with the LMS4684. The LMS4684 is a dual SPDT analog switch that will allow the MIC_P and MIC_N inputs of the LM4931 to switch between a differential handset microphone and a single-ended handsfree microphone. The MIC DETECT block shown in Figure 16 can be implemented with a microphone jack's mechanical control pin to set the voltage at the IN1 and IN2 pins of the LMS4684. The voltage applied at the IN1 and IN2 pins sets the position of the switch. For a more detailed discussion on the operation of the analog switch, please refer to the LMS4684 datasheet.

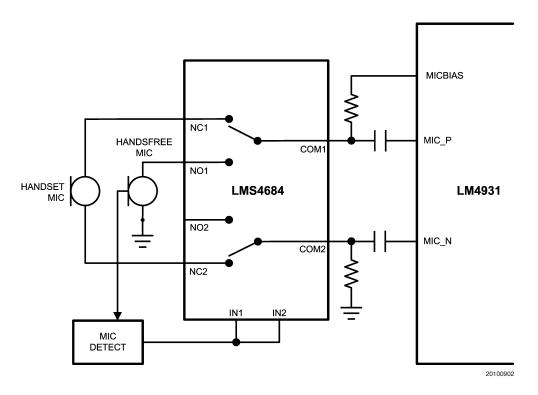
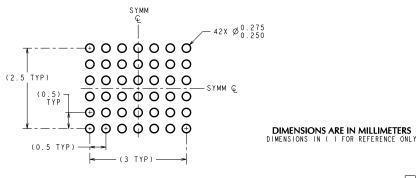
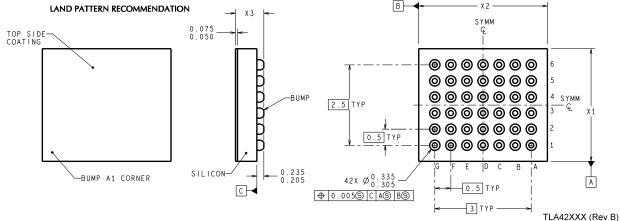


FIGURE 15. Dual Mirophone Setup

Physical Dimensions inches (millimeters) unless otherwise noted





42-Bump micro SMD Order Number LM4931ITL NS Package Number TLA42YVA $X_1 = 3.507 \pm 0.03$ mm $X_2 = 3.931 \pm 0.03$ $X_3 = 0.600 \pm 0.075$

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